



Single-Event Effects

Part 1 - General Principles

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**Special thanks to R. Davies and M. Casey*

Module 3: Objective and Outcomes

- This module will
 - Review SEE
 - Introduce the basic principles of accelerator facilities used for SEE testing
 - Describe the properties of ground test facilities related to microelectronics test requirements
 - Outline the necessary measurements for obtaining accurate SEE models
 - Provide a practical guide for preparing for an SEE experiment
- Student Outcomes
 - 1. Students will demonstrate an understanding of critical ground test properties and variables and how they influence test performance requirements.
 - 2. Students will be able to describe the beam structure, method of delivery, and the beam's influence on an experiment.



Outline

- Charge Generation due to Single-Events (Review of Module 2)
- Charge Collection
- Summary of SEE Charge Generation and Collection
- SEE Radiation Facility Basics
 - Accelerators
 - Beam basics
 - Properties of ground test parameters
 - Available beams
- Measuring SEE
 - SEE Cross Section and LET Threshold
 - Modeling SEE Cross Section
 - Sensitive Volume
 - From Experiment to On-orbit Rate Estimate
- Practical Considerations



Motivation

A Little Single-Event History

- 1962 Prediction of space-system upsets from ionizing particles
Wallmark and Marcus, RCA
 - 1975 Cosmic-ray-induced upsets observed in spacecraft BJT flip-flop circuits
Binder and Smith, Hughes
 - 1978 Upsets in 16k DRAMs observed and attributed to alpha particles from packaging contaminants
May and Woods, Intel
 - 1978 Cosmic-ray-induced upsets observed in spacecraft RAM circuits
Pikel and Blandford, Rockwell
 - 1979 Heavy-ion-induced latchup in SRAMs discovered
 - 1983 Galileo refit
- 1989 Solar Flare Event:**
- INTELSAT 46 pitch glitches, potential orbit disruption
 - TDRS-A 53 hits in 3 days, near catastrophic loss of attitude control



Bottom Line

- Single event effects (SEEs) are taking a prominent position in the mainstream integrated circuit industry
- Many commercial manufacturers are coming to grips with the problem as a key reliability issue
- The problem is of growing importance as noise margins diminish with scaling
- GHz logic, terabyte RAM, low-power circuits are leading to new upset scenarios
- Clearly, there is a recognized need for SEE analysis integrated into accepted design flows



Definitions

Single Event (SE) or Single Event Phenomena (SEP) -
interaction of a single ionizing particle with a semiconductor device -
localized interaction - event occurrence does not depend on flux or
total exposure - event is spatially and temporally random - event seems
(though not scientifically verified) to perfectly implement Murphy's Law

Single Event Effect (SEE) -
a circuit or system response to a SE

Single Event Upset (SEU) -
a bit flip or other *corruption* of stored information due to an SEE
(usually applied to memory circuits)

Single Event Error or Soft Error-
the observable, measurable *manifestation* of an SEE as a incorrect
circuit operation (usually a system response)



Definitions (cont)

Single Event Transient (SET)

- a signal glitch caused by an SE
- ASET - analog single event transient
- DSET - digital single event transient

Single Event Error Rate or Soft Error Rate (SER) -

the frequency of errors in a particular environment (e.g. an orbit, mission trajectory, etc) -- can be related to FITs



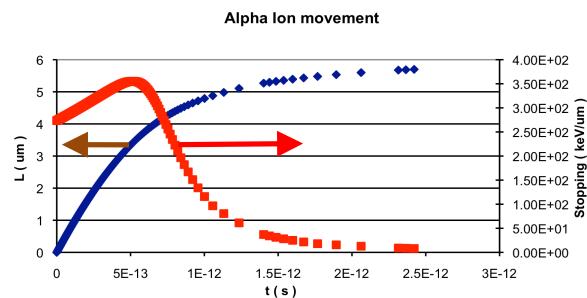
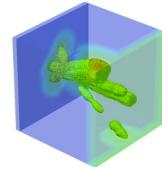
01

CHARGE GENERATION DUE TO SINGLE EVENTS

Interactions of the Particles with Semiconductors

Energy Loss or Stopping Power

- Charged particle passes through a material
- Loses energy by Rutherford scattering with the lattice nuclei
- Energy transferred to bound electrons -- ionized into the conduction band
- Imparts a dense track of electron hole pairs (EHPs)



Interactions of the Particles with Semiconductors

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Incremental rate of energy loss along the ion's path

= stopping power (dE/dx)

units of energy per unit length (typical: MeV/cm)



Interactions of the Particles with Semiconductors

LET and the Amount of Charge Liberated

Stopping power: Depends on mass, energy of particle and density of material

Linear energy transfer (LET) normalizes out the density of the target material
(units = MeV/mg/cm²)

$$\text{LET (MeV/mg/cm}^2\text{)} * \text{Target Density (mg/cm}^3\text{)} = \text{Energy deposition (MeV/cm)}$$

Charge creation: 3.6 eV needed to create one EHP in silicon

Amount of charge liberated (pC/μm) = LET (MeV/mg/cm²) * 0.01035
(approximately 100 to 1 conversion factor)
(e.g. Particle of LET=100 MeV/mg/cm² → 1 pC/μm)

Stopping powers and LETs for various ions, energies, and target material are tabulated, or can be calculated using SRIM code
(www.srim.org)



LET – Linear Energy Transfer

- The rate of ionization energy deposition per unit of path length

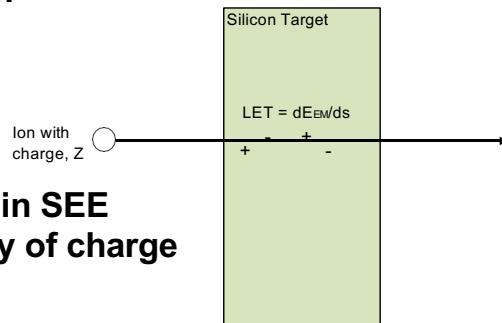
$$\text{LET} = \frac{dE_{\text{EM}}}{ds}$$

- s is along the path of the particle

- LET is a critical metric for beams used in SEE testing because it quantifies the density of charge generated inside the target material

- LET depends on

- Charge of ion, Z
- Target Material
- Energy of ion
 - Initial → “Surface LET”
 - At each location along the ion’s path → Instantaneous LET



Linear Energy Transfer (LET) is a fundamental quantity necessary in radiation effects modeling. LET is an approximation for the amount of energy a particle loses as it travels through a material. This energy transfer (deposition) is what leads to charge generation, and ultimately, to SEE and TID. LET is defined as the energy loss over the path length, s , traveled through the material.

LET depends on the energy and charge (atomic mass) of the ion, but also the density of the target material.

LET – Units

- The rate of ionization energy deposition per unit of path length

$$\text{LET} = \frac{dE}{ds}$$

- s is along the path of the particle

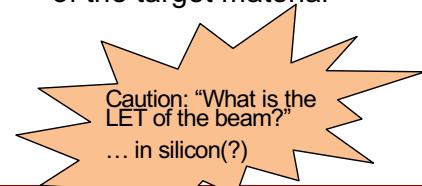
- LET is a critical metric for beams used in SEE testing because it quantifies the density of charge generated inside the target material
- LET is dependent on the target material!!

- LET units

- MeV·cm²/mg

- Think of it as:

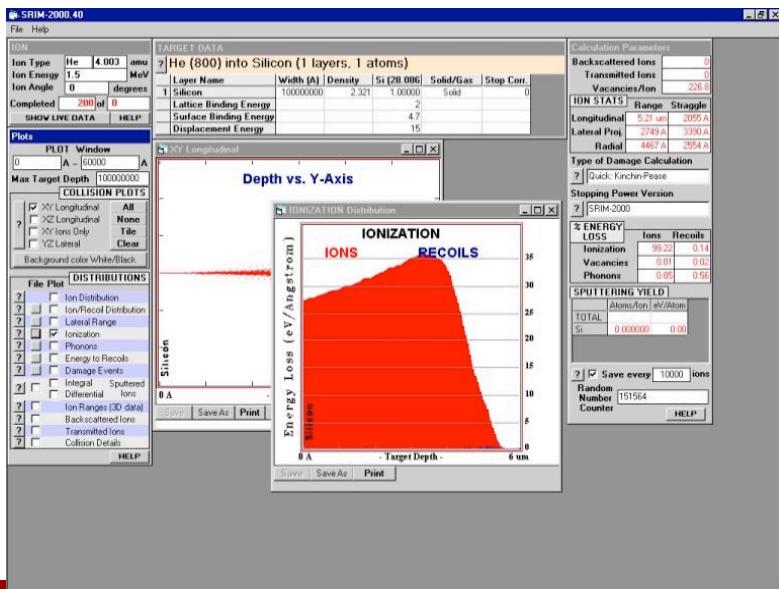
- MeV/(mg/cm²)
- MeV/(cm · mg/cm³) → $dE/(ds \cdot \delta)$
- Energy deposited per unit of length normalized by density of the target material



Thus, LET is energy deposited per unit of length normalized by density of the target material. Note that LET is not a quality of the radiation, but a result of the interaction of the radiation with the material.

Interactions of the Particles with Semiconductors

SRIM Calculations



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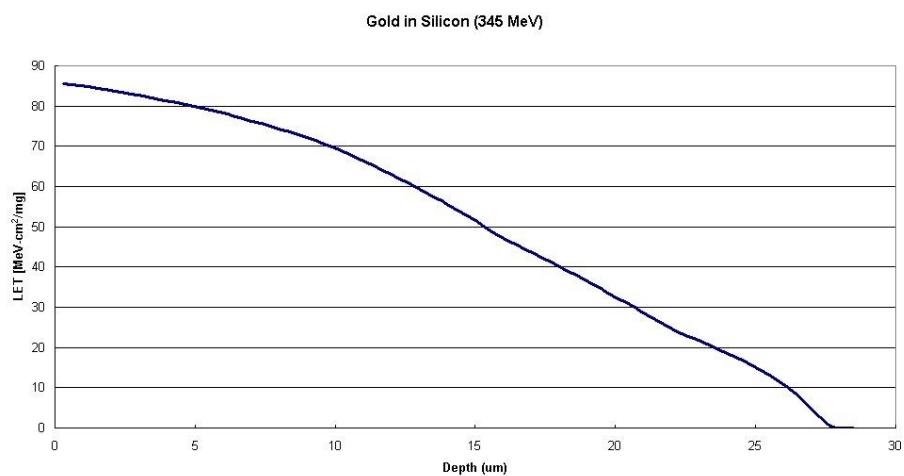
Module 3: Single-Event Effects

CHARGE GENERATION

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LET Curves for Typical Ions

Heavy-Ion Beam Examples (Brookhaven)



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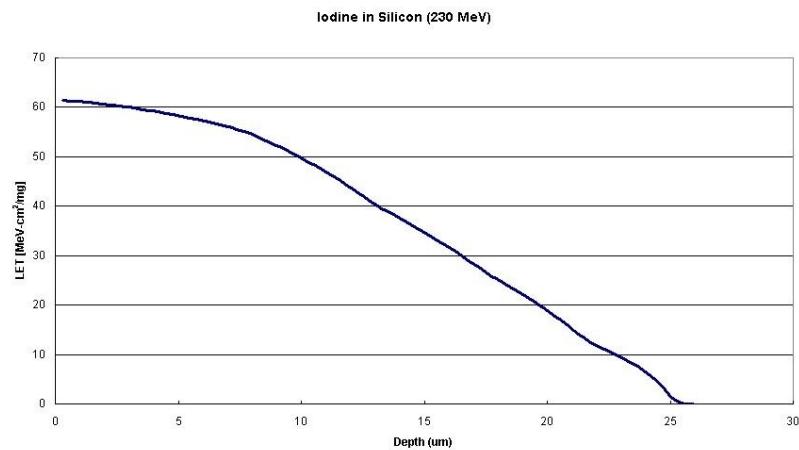
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LET Curves for Typical Ions

Heavy-Ion Beam Examples (Brookhaven)



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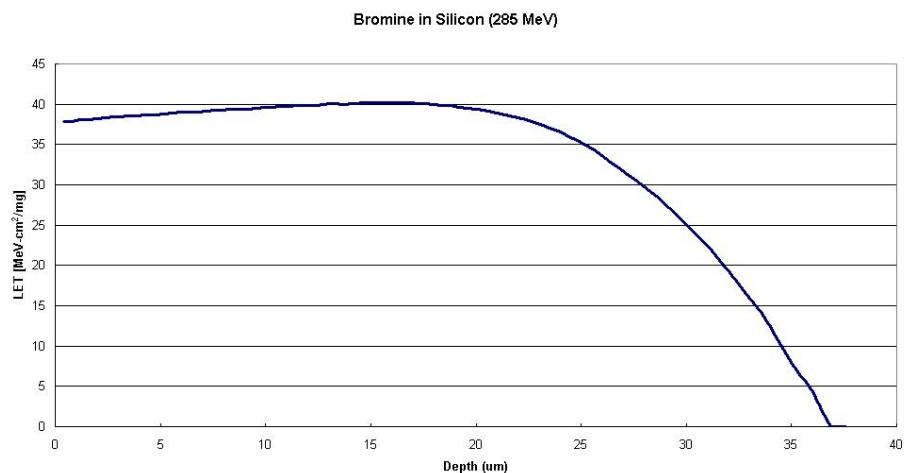
Module 3: Single-Event Effects

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LET Curves for Typical Ions

Heavy-Ion Beam Examples (Brookhaven)



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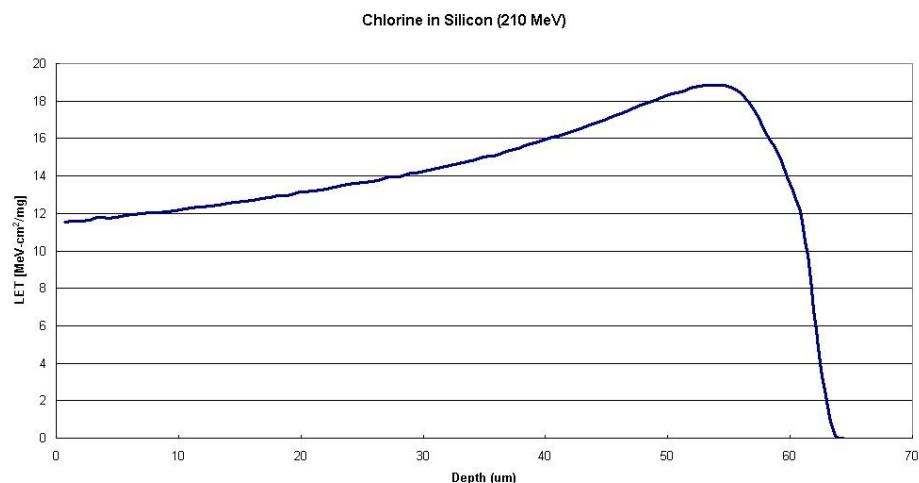
Module 3: Single-Event Effects

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LET Curves for Typical Ions

Heavy-Ion Beam Examples (Brookhaven)



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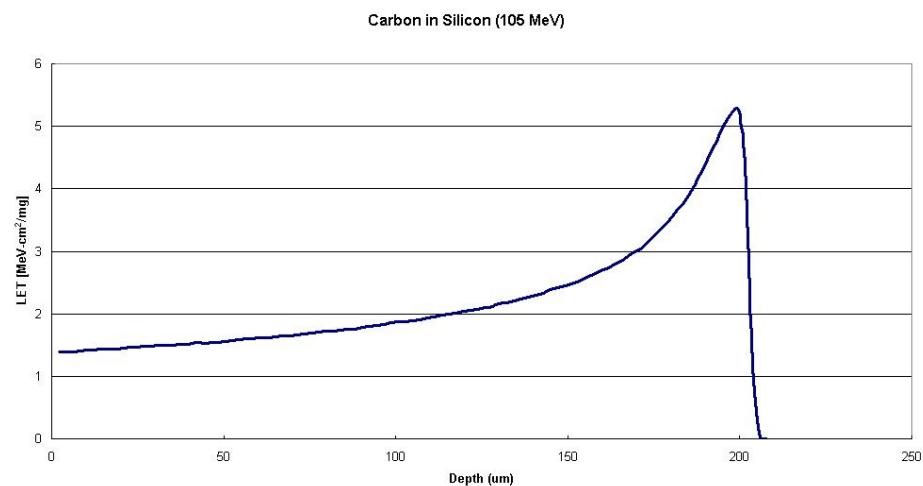
Module 3: Single-Event Effects

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LET Curves for Typical Ions

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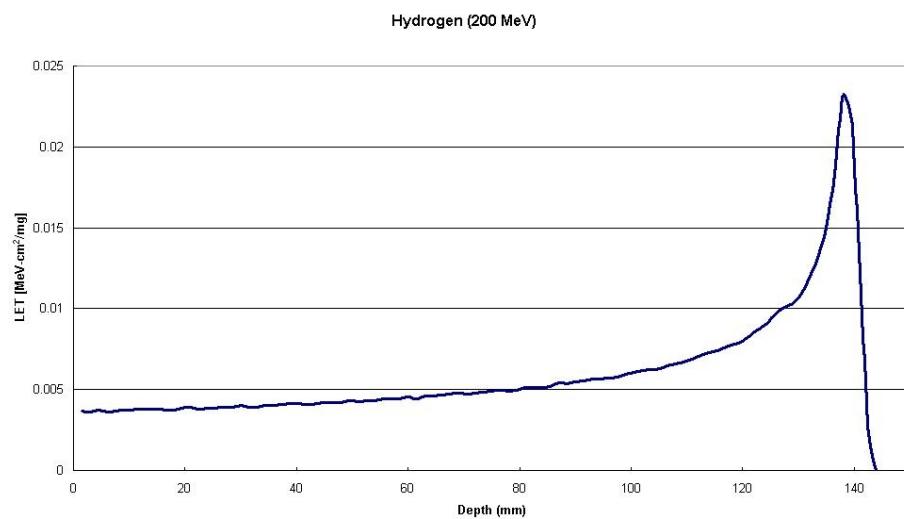
Module 3: Single-Event Effects

CHARGE GENERATION

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LET Curves for Typical Ions

Proton Beam Examples (Indiana University)



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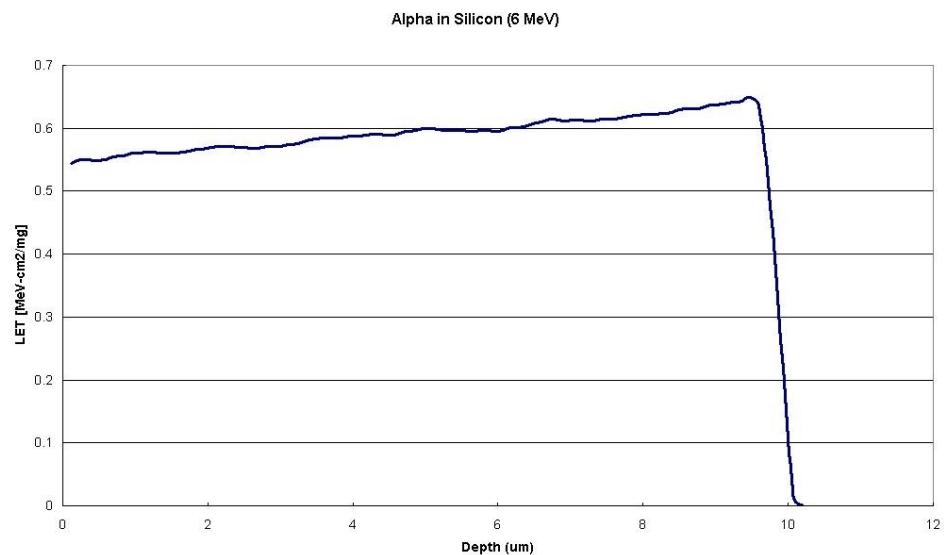
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LET Curves for Typical Ions

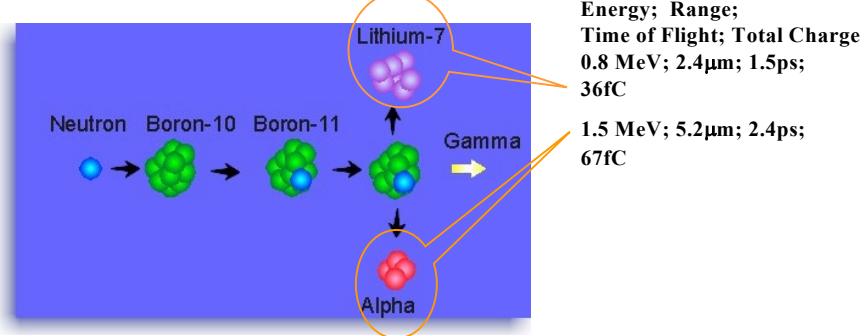
Packaging/Impurity Alpha Example



Terrestrial Neutrons

Created by cosmic ion interactions with oxygen and nitrogen in the upper atmosphere

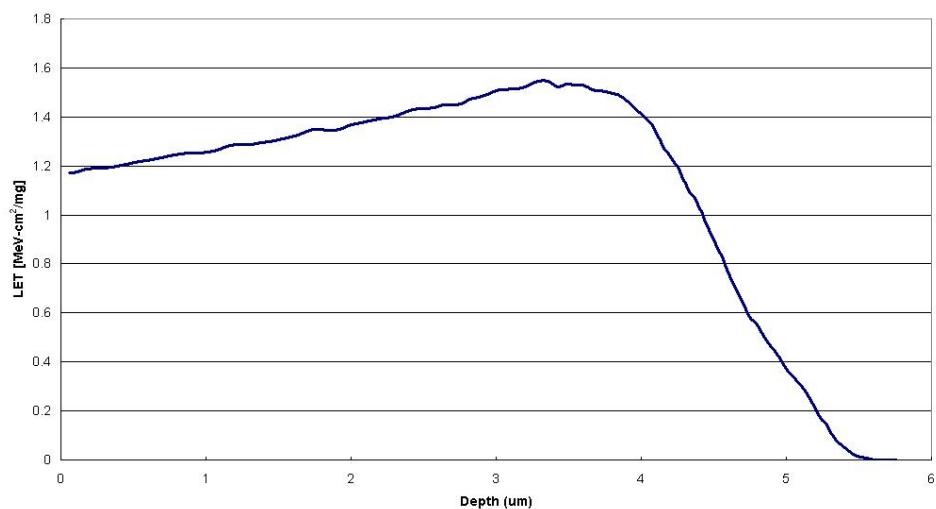
Example thermal neutron reaction:



LET Curves for Typical Ions

Terrestrial Neutron Product Examples

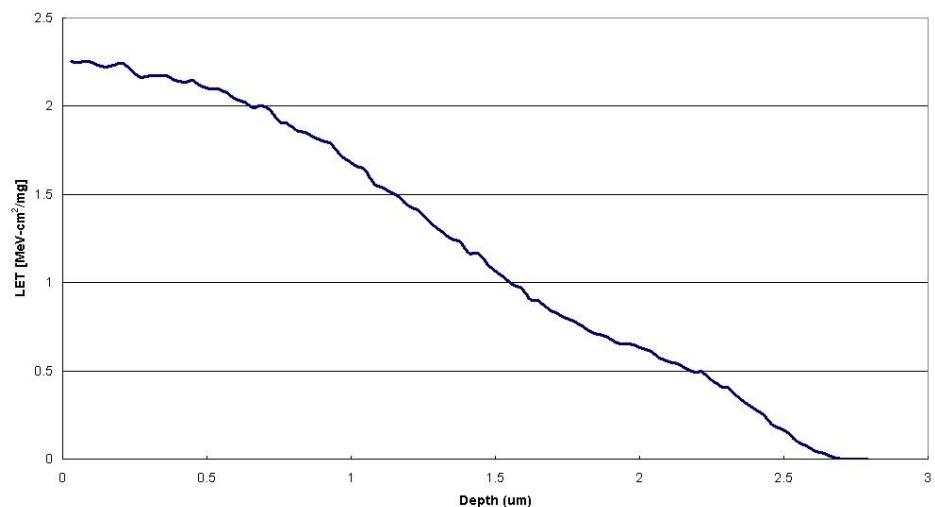
Alpha in Silicon (1.5 MeV)



LET Curves for Typical Ions

Terrestrial Neutron Product Examples

Lithium in Silicon (.8 MeV)



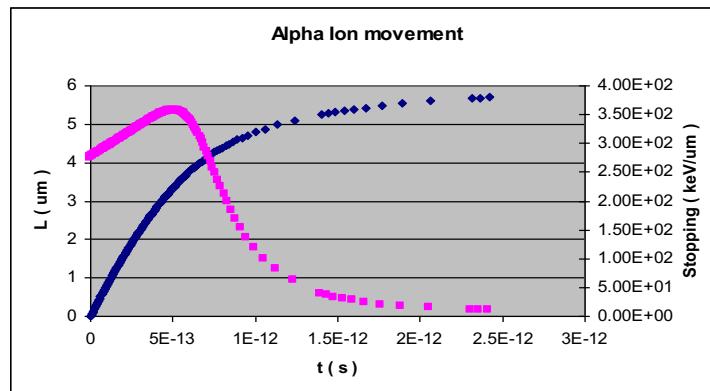
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CHARGE GENERATION

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Further Information from Stopping Power Data

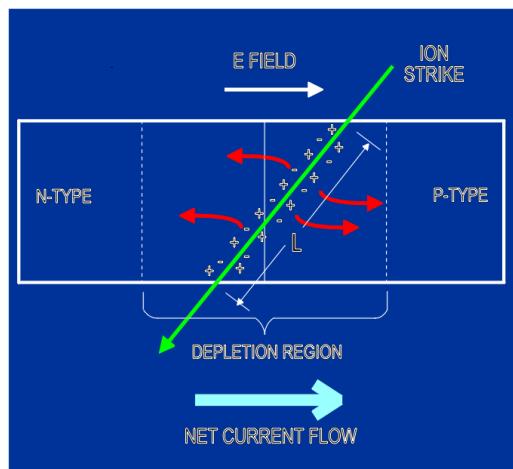


02

CHARGE COLLECTION

Depletion Region (Drift) Charge Collection

Simple P-N Junction, Prompt Current



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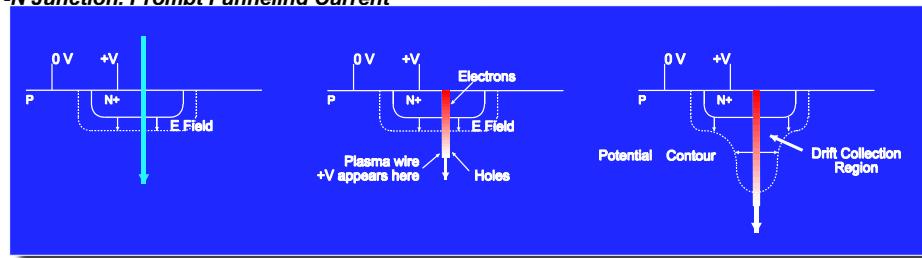
Module 3: Single-Event Effects

CHARGE COLLECTION

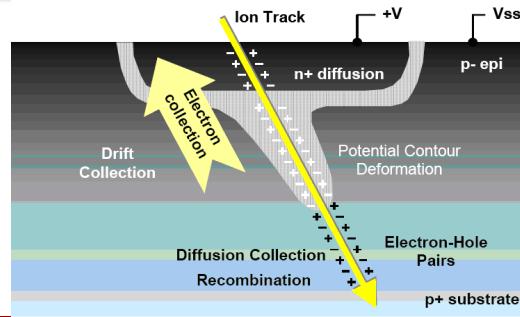
28

Enhanced Drift Charge Collection (Field Funneling)

Simple P-N Junction. Prompt Funneling Current

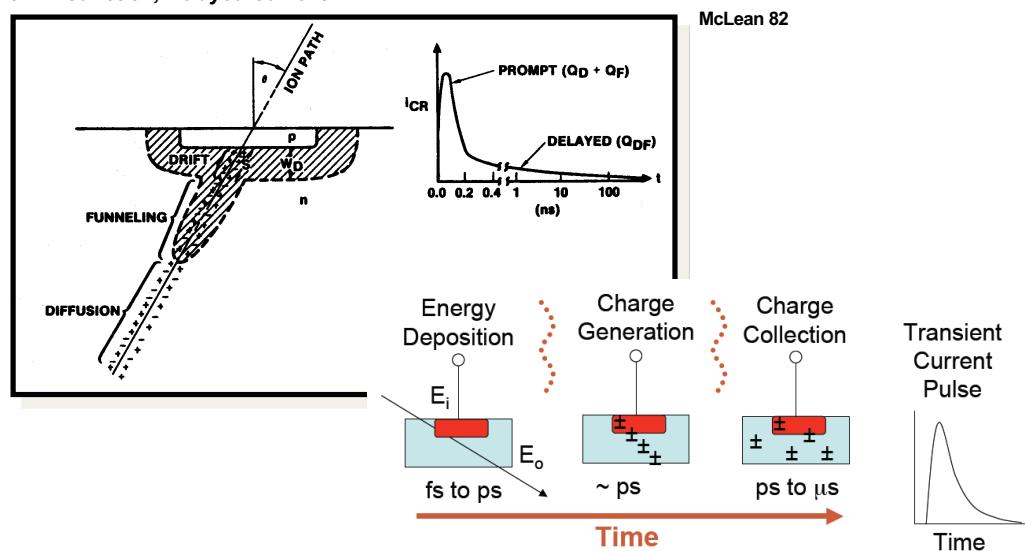


The track of ionized carriers can perturb the depletion region traversed by the path, leading to enhanced collection via drift processes



Diffusion Collection

Simple P-N Junction, Delayed Current



McLean 82



CREATE

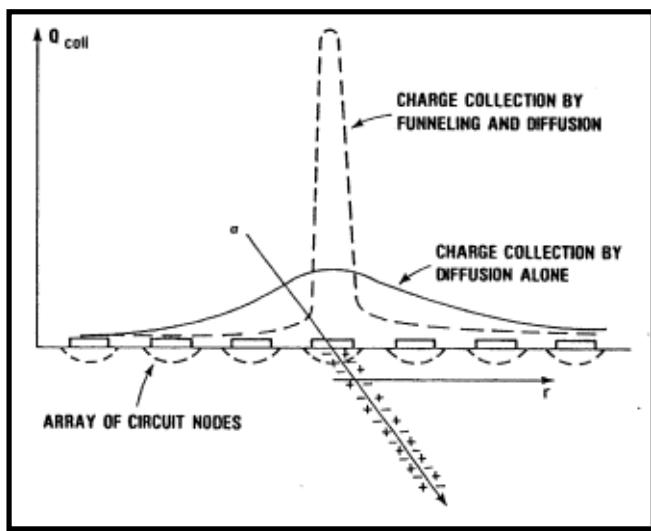
Module 3: Single-Event Effects

CHARGE COLLECTION

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Diffusion Collection

Simple P-N Junction, Delayed Current



Pickel 83



CREATE

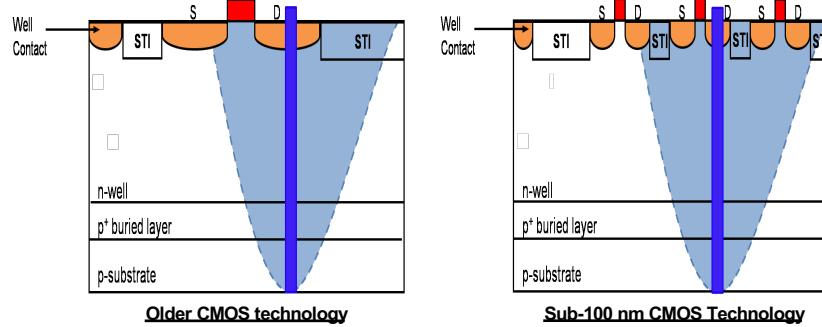
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CHARGE COLLECTION

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Charge Sharing

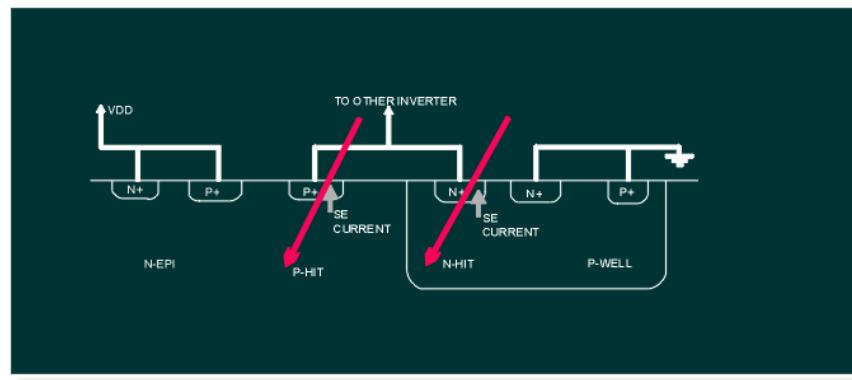
- Single-event (SE) generated charge may be “shared” between the device directly penetrated by the ionizing particle (hit device) and proximal devices
- Scaling technology increases the probability of charge sharing due to decreased device sizes and decreased device spacing



Complex Geometries

CMOS Structure

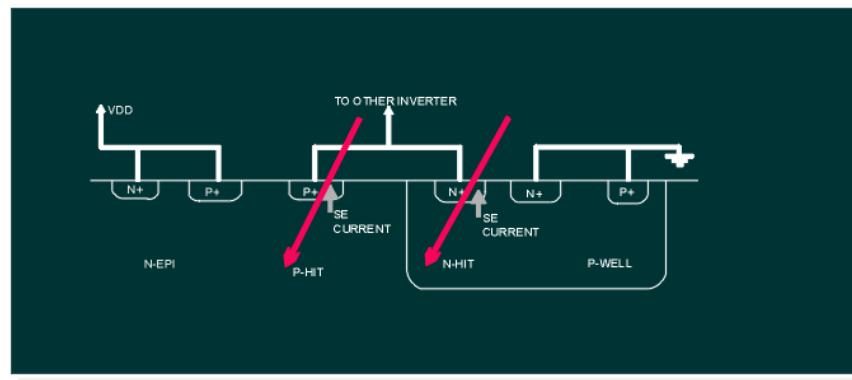
Charge collection influenced by neighboring junctions or boundary conditions



Complex Geometries

CMOS Structure

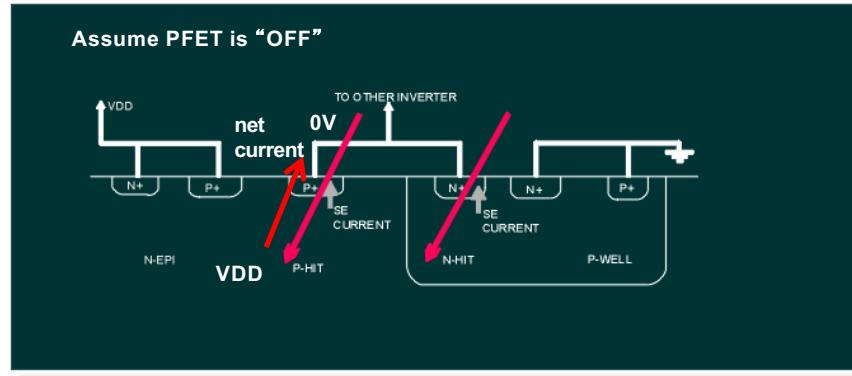
Charge collection influenced by neighboring junctions or boundary conditions
Junctions are vulnerable when reversed biased



Complex Geometries

CMOS Structure

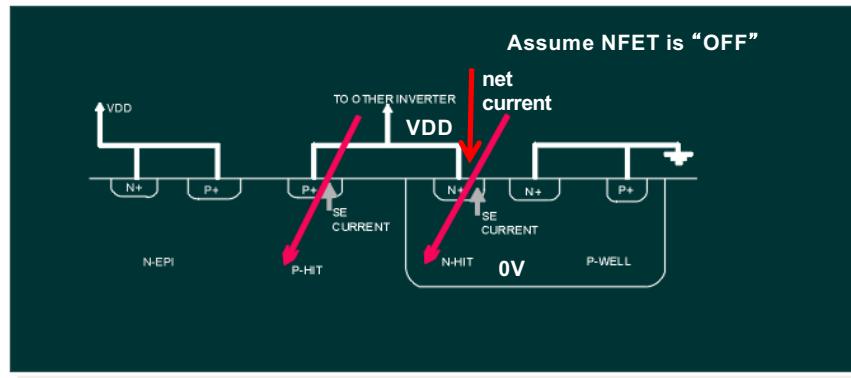
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Complex Geometries

CMOS Structure

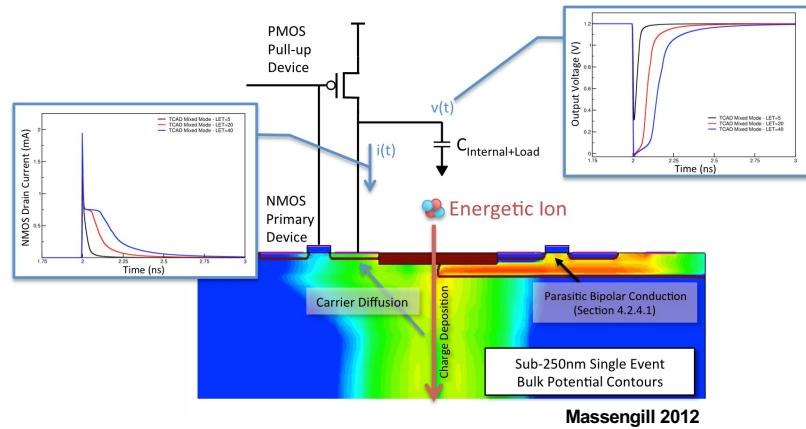
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Complex Geometries

CMOS Structure

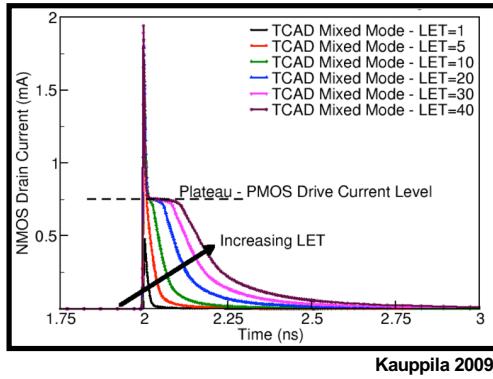
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Complex Geometries

CMOS Structure

Charge collection influenced by neighboring junctions or boundary conditions
Junctions are vulnerable when reversed biased



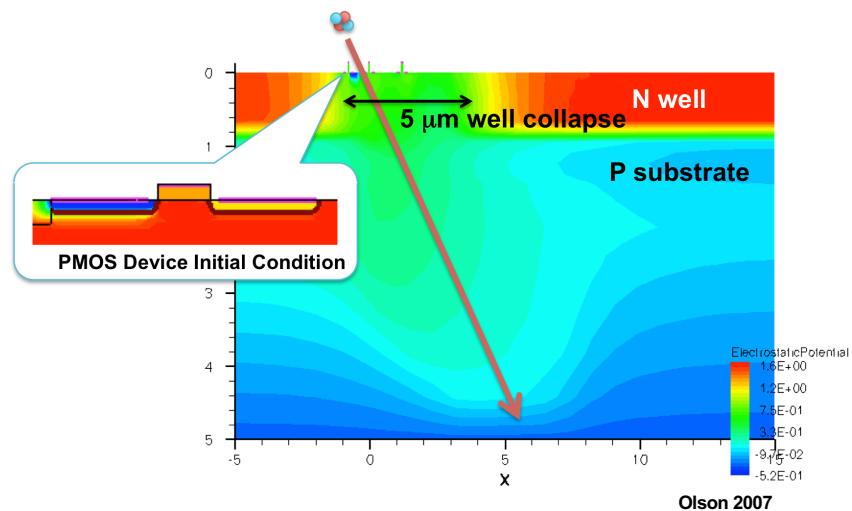
Kauppila 2009

The plateau region, caused by the collapse of the device depletion region, is the induced balance of charge collection current and resupply current)



Complex Geometries

Well Potential Collapse



Olson 2007



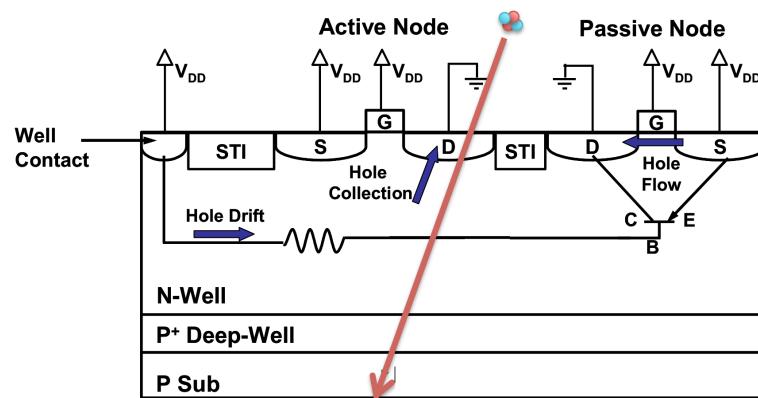
CREATE

Module 3: Single-Event Effects

CHARGE COLLECTION

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Parasitic Bipolar Action Due to Well Potential Collapse



Olson 2005



CREATE

Module 3: Single-Event Effects

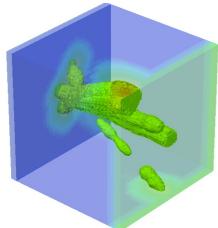
CHARGE COLLECTION

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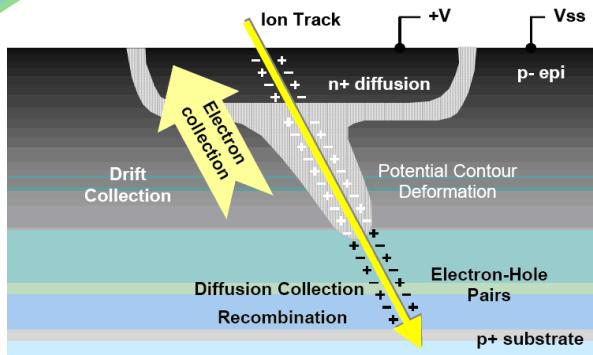
03

Summary of SEE Charge Generation and Collection

REMINDER: Single-Event Effects In Microelectronics



- Single-Event Effects (SEE):
 - Caused by the interaction of a single energetic particle



Ionizing Particles:

Heavy ions from deep space
(galactic cosmic rays)

Energetic protons
(trapped in the Van Allen belts)

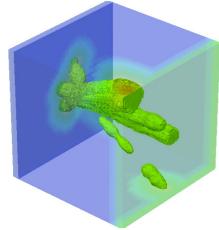
Neutron products
(terrestrial)

Alpha particles
(from contaminants)

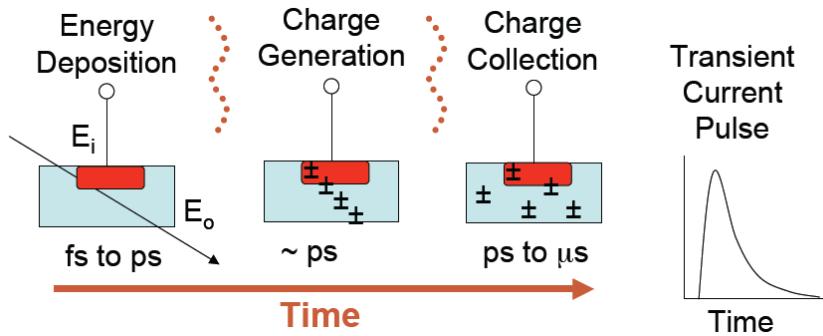
Example of Ion Penetrating Reverse-Biased p-n Junction



REMINDER: Single-Event Effects In Microelectronics



- Single-Event Effects (SEE):
 - Caused by the interaction of a single energetic particle
 - SEE are determined by:
 - Charge generation
 - Charge collection
 - Circuit response



04

SEE Radiation Facility Basics

Accelerators for SEE: Testing procedures are dependent on the chosen facility!

- The main types of facilities used for SEE testing are:
 - Linear accelerator (LINAC)
 - Cyclotron
 - Synchrotron
 - Other:
 - Tandem Van der Graff (TvdG)
 - Pulsed laser
 - Short-pulse X-ray

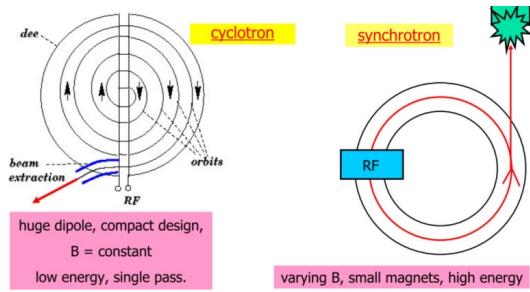
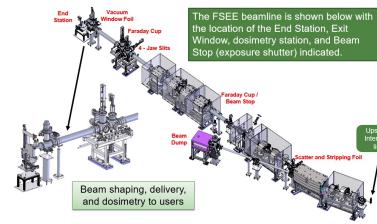


Image Credit: T. Olson, 2021



<https://frb.msu.edu/science/fsee>



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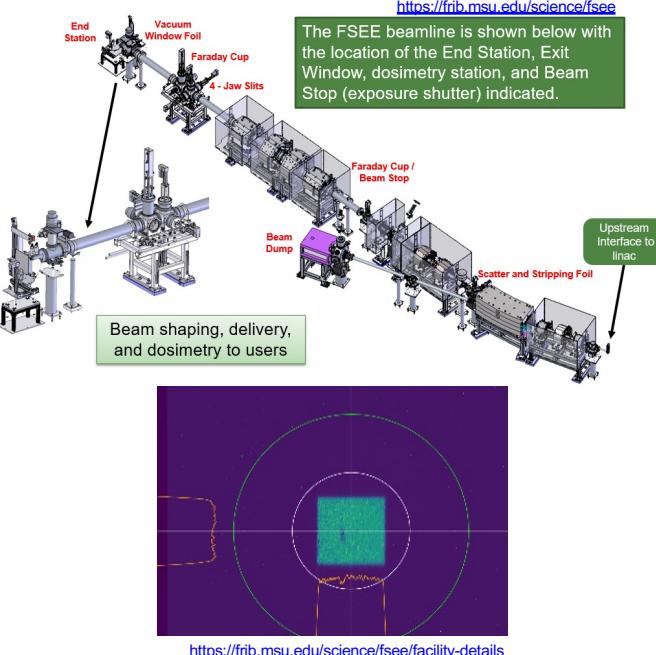
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Linear Accelerator (LINAC)

- LINACs include a series of RF cavities that use electromagnetic fields to accelerate particles and magnets to focus the beam through transport.
- Benefits:
 - Higher energy requires more stages and doesn't rely on magnetic field constraints
 - Good beam control and stabilization
- Limitations:
 - Higher energies require longer distances; e.g., the FRIB is approximately 450 ft long!
- Example: Michigan State University's (MSU) Facility for Rare Isotopes Beam (FRIB)



<https://frib.msu.edu/science/fsee/facility-details>



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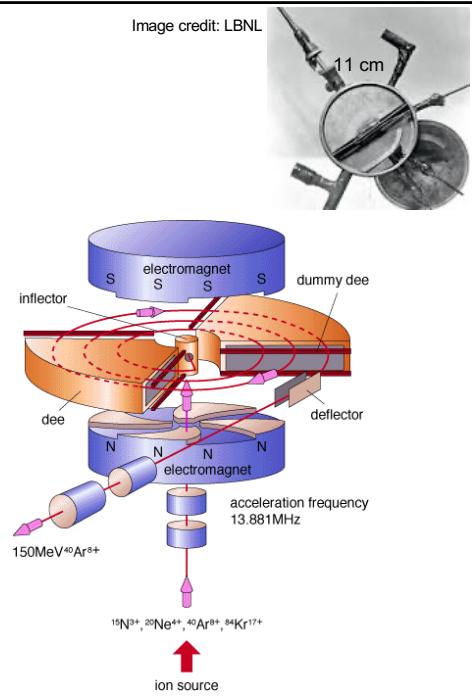
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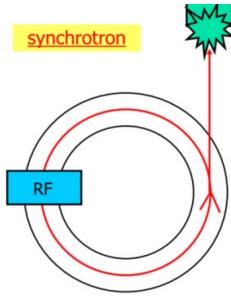
Cyclotrons

- Cyclotrons use a constant magnetic field and an alternating electric field, resulting in a “nearly” constant particle flux and are the most common for SEE testing
- Benefits:
 - Compact design and more cost effective (for low to moderate energies)
 - Continuous beam
- Limitations:
 - Large magnets required; higher energies require larger and stronger magnetic fields
- Examples:
 - Lawrence Berkeley National Laboratories (LBNL) 88": Heavy ion "cocktail" with 10, 16, & 20 MeV/amu
 - Texas A&M University's (TAMU) K500: 15-40 MeV/amu
 - TAMU K150: 15 MeV/amu
 - TRIUMF 520 MeV

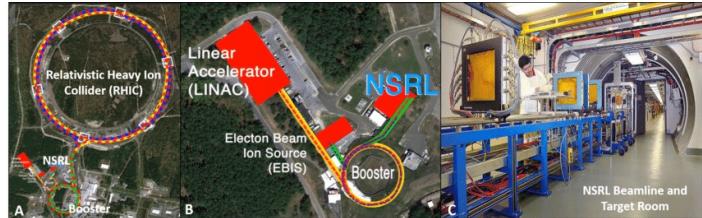


Synchrotrons

- Synchrotrons allow for higher energy beams than LINACs and Cyclotrons. Particles are compressed into separate bunches spaced on a scale of RF wavelength. Bunches are contained in a ring and pass through RF cavities that provide successive energy increases.
- Limitations:
 - High cost and space requirements
 - Pulses or “bunches” of particles can complicate SEE testing
- Example
 - NASA Space Radiation Laboratory (NSRL) at Brookhaven National Laboratory (BNL):
30 MeV/amu to > 1 GeV/amu



varying B, small magnets, high energy
Image Credit: T. Olson, 2021



At NSRL:

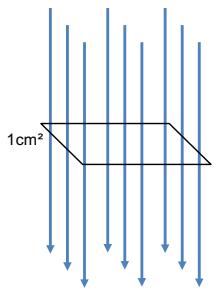
The ions are delivered to the target room in 300 ms spills approximately every 3.7 s!

Beam Basics - Flux and Fluence

Flux: The rate of beam particles passing through a unit area

Question: Is flux always constant?

Beam particles in 1 second



$$\text{Flux} = 9 \text{ /cm}^2\text{/s}$$



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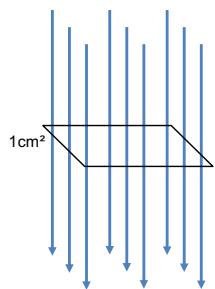
Pause, ask question to connect to accel type

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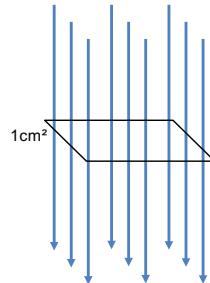
Beam particles in 1 second



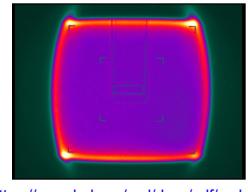
$$\text{Flux} = 9 \text{ /cm}^2\text{/s}$$

Fluence: The total number of beam particles passing through a unit area in over some period of time

Beam particles during an entire run



$$\text{Fluence} = 9 \text{ /cm}^2$$



<https://www.bnl.gov/nsrl/docs/pdf/nsrl-electronics-testing.pdf>



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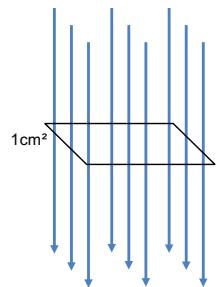
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Beam Basics - Flux and Fluence

Flux: The rate of beam particles passing through a unit area

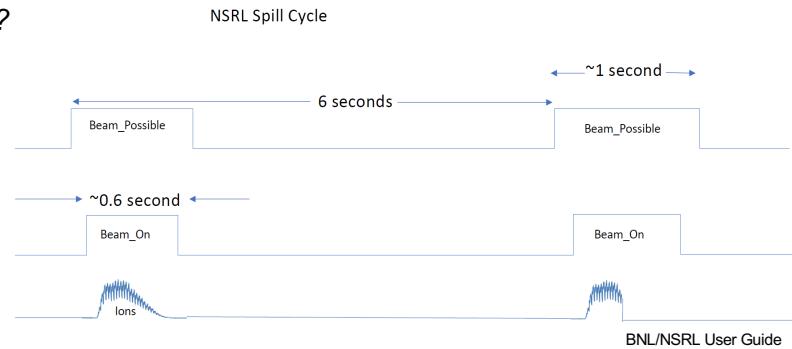
Question: Is flux always constant?

Beam particles in 1 second



$$\text{Flux} = 9 \text{ /cm}^2\text{/s}$$

Synchrotrons release radiation in “spills”



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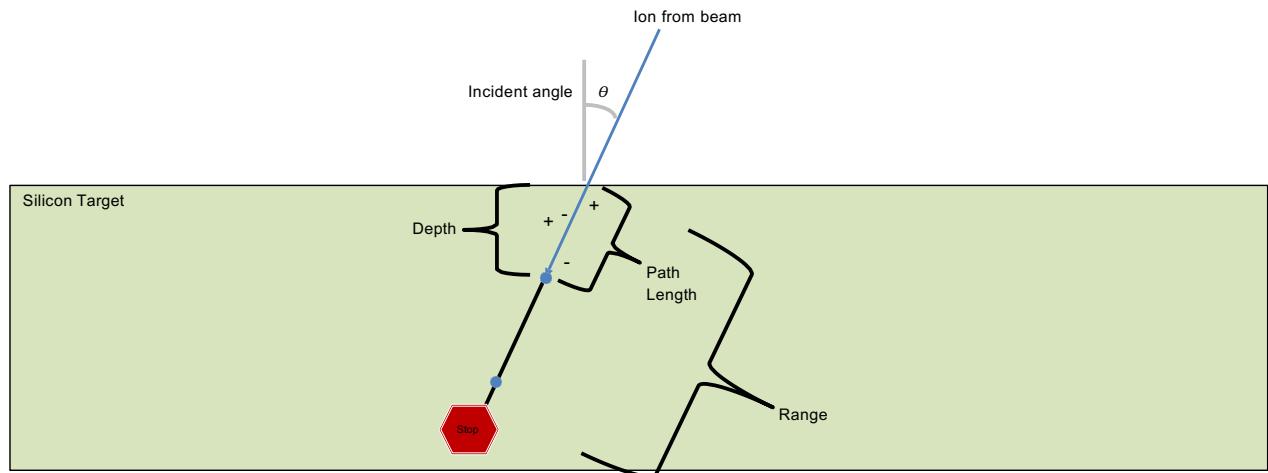
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Pause, ask question to connect to accel type

Beam Basics - Geometry



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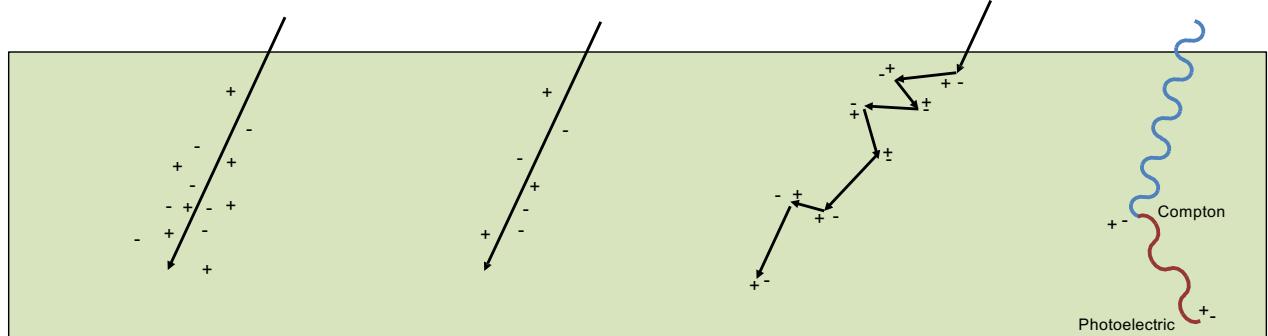
Module 3: Single-Event Effects

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Particle Track

- Heavy Ion ($Z \geq 2$)
- Proton ($Z=1$)
- Electron
- Photon



CREATE

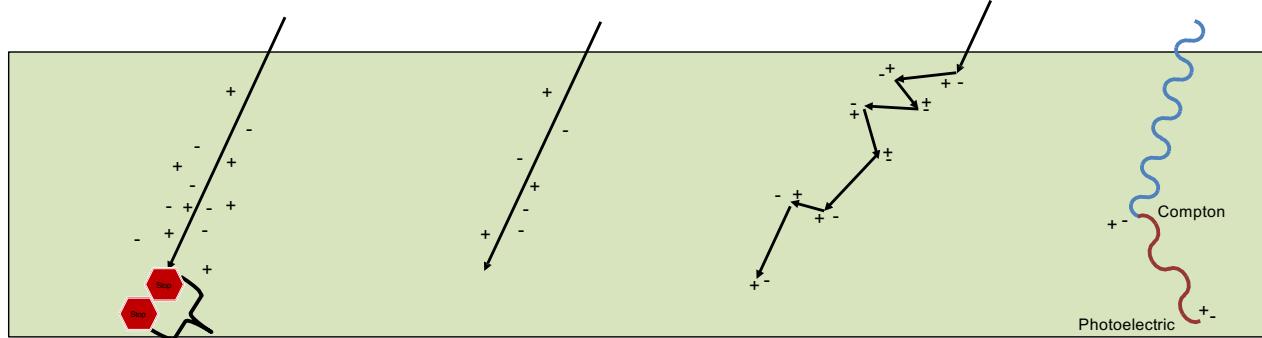
Module 3: Single-Event Effects

SEE FACILITY BASICS

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Particle Track

- Heavy Ion ($Z \geq 2$)
- Proton ($Z=1$)
- Electron
- Photon



Straggling: variation in total range of individual beam particles due to probabilistic nature of interactions. Thus, the "Range" of a beam is not exact.

Mean free path: average distance travelled by a beam particle between interactions that change its path or energy.



CREATE

Module 3: Single-Event Effects

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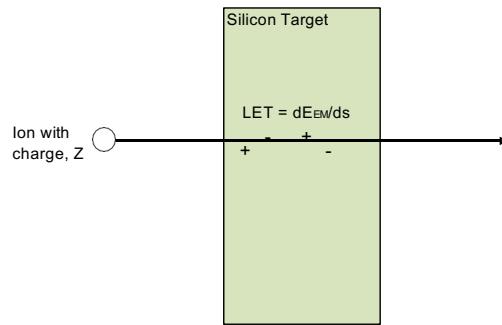
54

LET – Linear Energy Transfer

- The rate of ionization energy deposition per unit of path length

$$\text{LET} = \frac{dE_{\text{EM}}}{ds}$$

- s is along the path of the particle
- LET is a critical metric for beams used in SEE testing because it quantifies the density of charge generated inside the target material

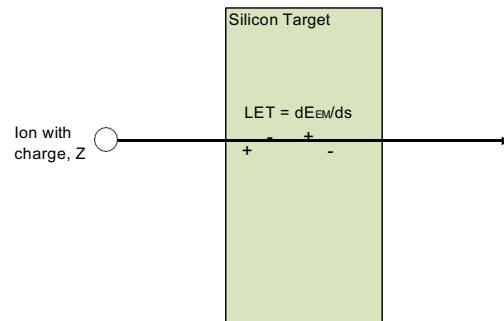


LET – Linear Energy Transfer

- The rate of ionization energy deposition per unit of path length

$$\text{LET} = \frac{dE_{\text{EM}}}{ds}$$

- What influences LET?



CREATE

Module 3: Single-Event Effects

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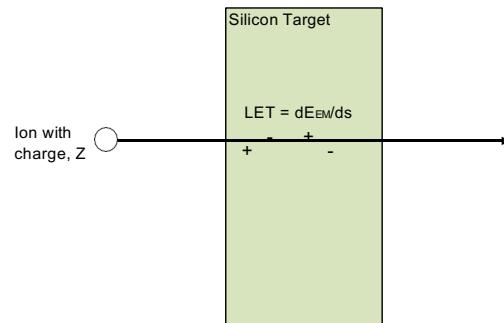
56

LET – Linear Energy Transfer

- The rate of ionization energy deposition per unit of path length

$$\text{LET} = \frac{dE_{\text{EM}}}{ds}$$

- What influences LET?
 - Charge of ion, Z
 - Target Material
 - Energy of ion
 - Initial → “Initial LET”
 - At each location along the ion’s path → Instantaneous LET



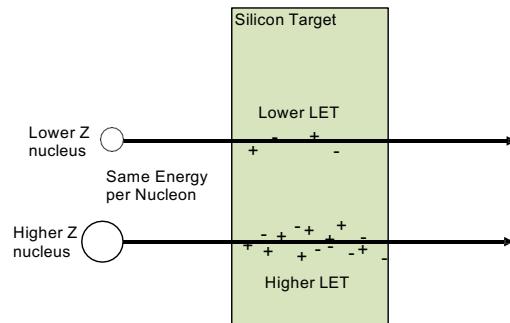
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$$LET = \frac{dE_{EM}}{ds}$$

- What influences LET?

- Charge of ion, Z
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- Energy of ion
 - Initial → “Initial LET”
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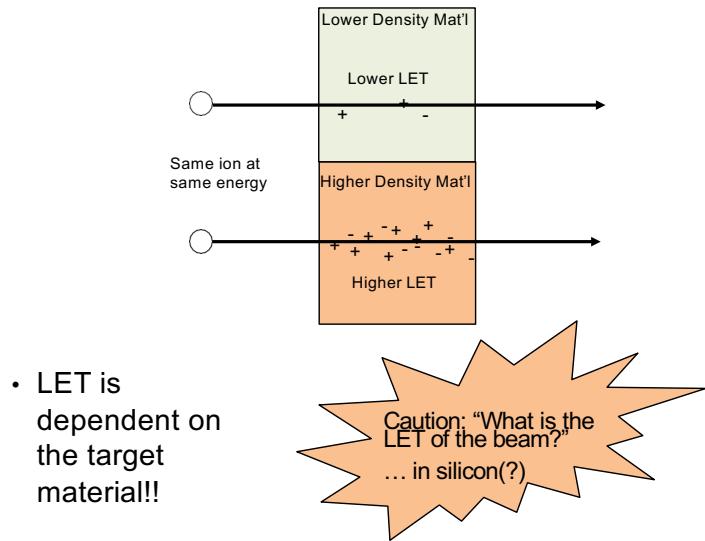


- Higher Z ions are more stressing from an SEE test standpoint, i.e., they have higher LET (everything else being the same)



LET – Linear Energy Transfer

- The rate of ionization energy deposition per unit of path length
- $LET = dE_{EM} / ds$
- s is along the path of the particle
- LET is a critical metric for beams used in SEE testing because it quantifies the density of charge generated inside the target material.



- LET is dependent on the target material!!



LET – Units

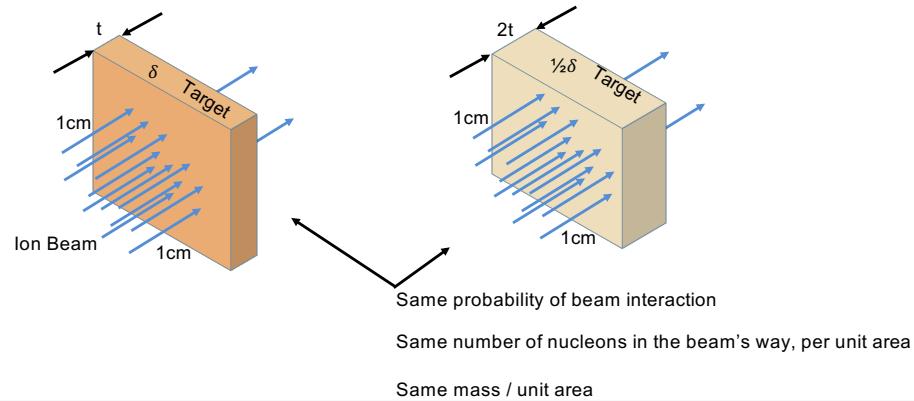
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- $LET = \frac{dE_{EM}}{ds}$
- s is along the path of the particle
- LET is a critical metric for beams used in SEE testing because it quantifies the density of charge generated inside the target material.

- LET units
 - MeV·cm²/mg
 - Think of it as:
 - MeV/(mg/cm²)
 - MeV/(cm · mg/cm³) → $dE/(ds * \delta)$
 - Energy deposited per unit of length normalized by density of the target material



Target Density

- Just as chance of interaction can be increased by increasing t , it can similarly be increased by **increasing density**

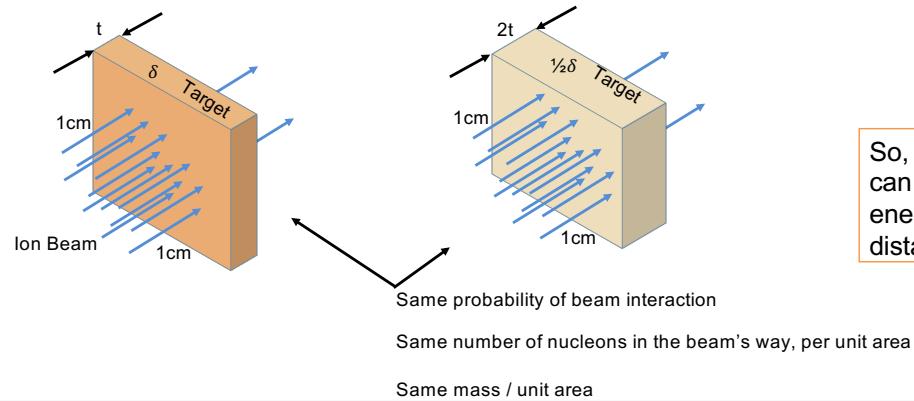


"Thickness" can be thought of as mass per unit area of the target



Target Density

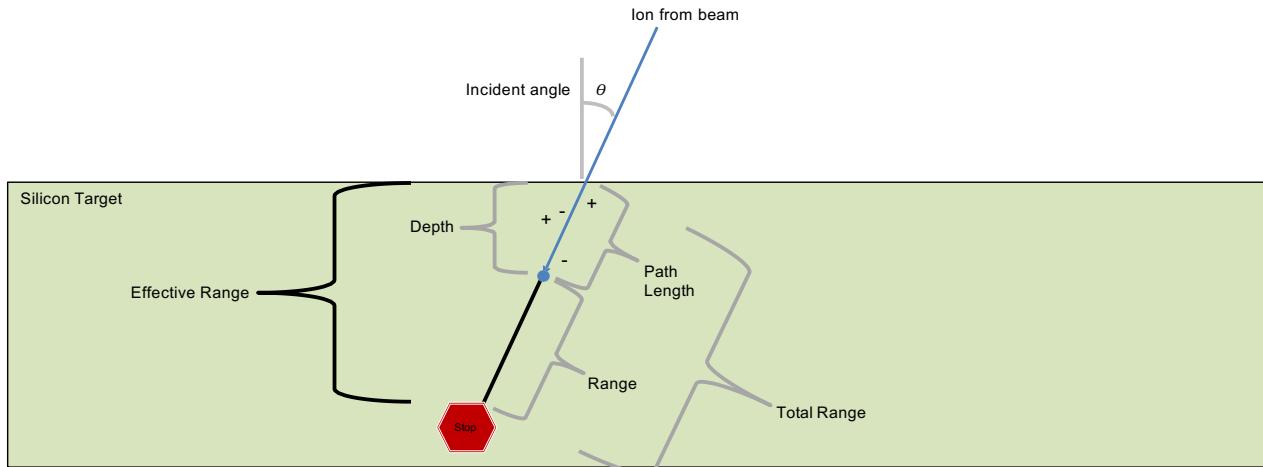
- Just as chance of interaction can be increased by increasing t , it can similarly be increased by **increasing density**



"Thickness" can be thought of as mass per unit area of the target



Beam Basics – Orientation

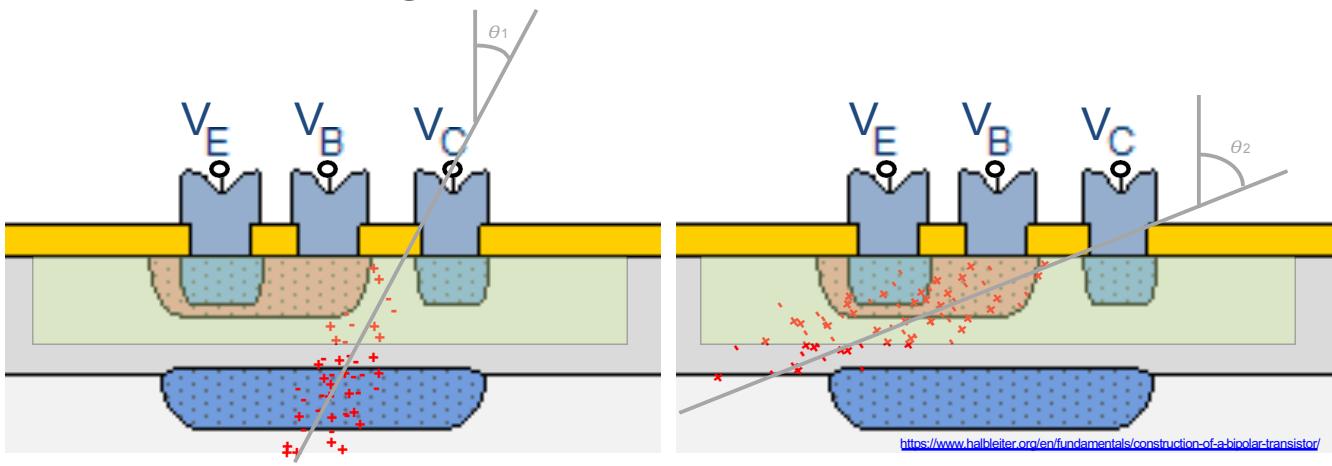


Effective LET → LET as if the beam were normally incident

Effective Range → Range as if the beam were normally incident



Influence of Angle of Incidence



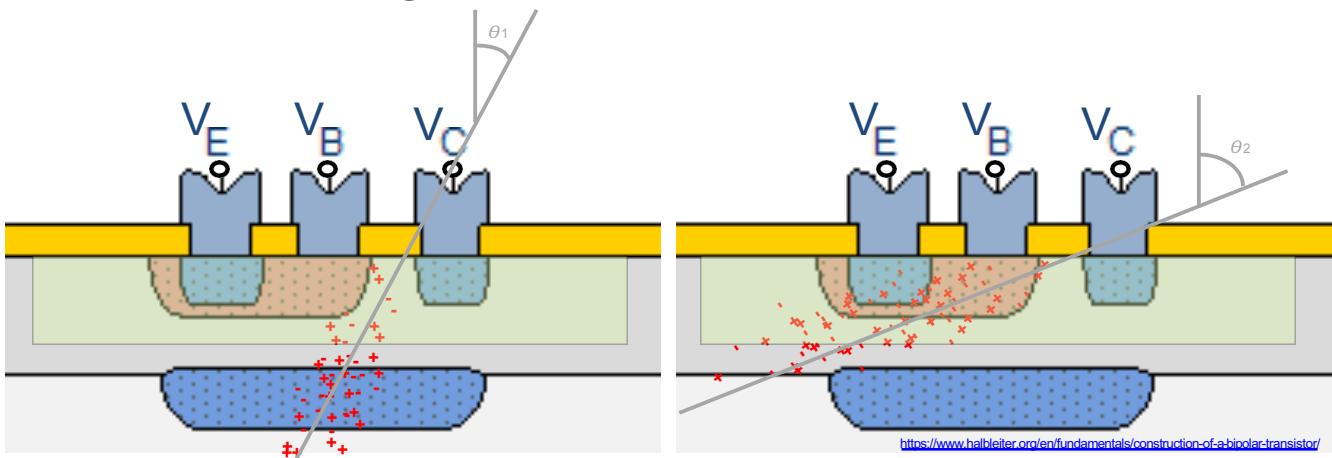
CREATE

Module 3: Single-Event Effects

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Influence of Angle of Incidence



- Larger angle of incidence deposits greater charge in "sensitive volume (SV)"
- **True or false:** Larger angle of incidence is comparable to being hit with a higher LET ion? Why or why not?



CREATE

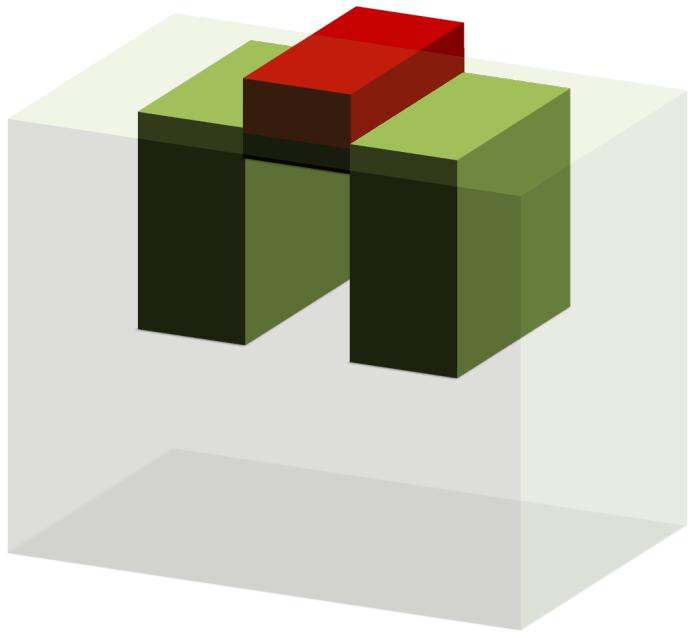
Module 3: Single-Event Effects

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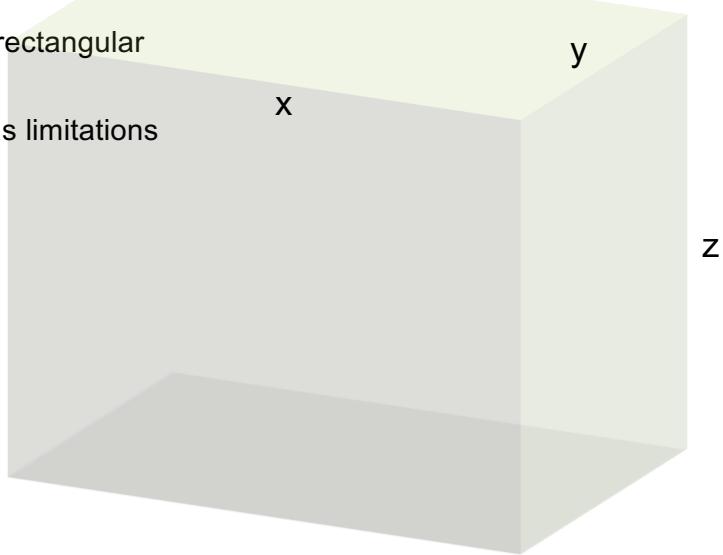
Sensitive Volume (SV)

- SV = Region of a device within which charge can contribute to SEE
- Critical Charge (Q_{CRIT}) = The threshold of charge in the SV that will result in an SEE of interest



Rectangular Parallel Piped (RPP) Model

- RPP is an abstraction as if the SV truly is rectangular
- Useful conceptually, but be careful as it has limitations



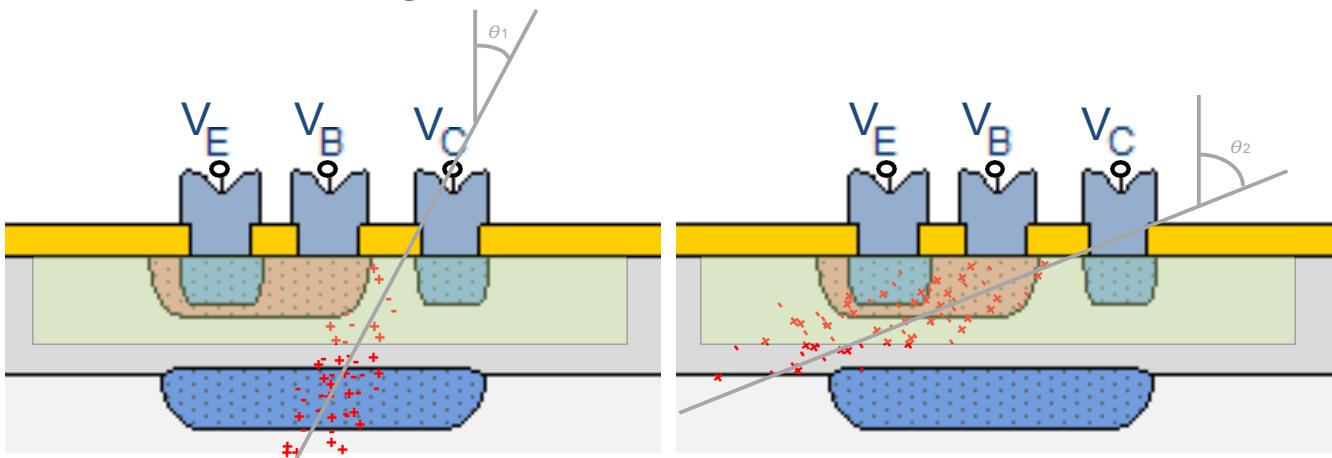
CREATE

Module 3: Single-Event Effects

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Influence of Angle of Incidence



- Larger angle of incidence deposits greater charge in SV
- Comparable to being hit with a higher LET ion
- Effective LET: $LET_{eff} = LET / \cos(\theta)$



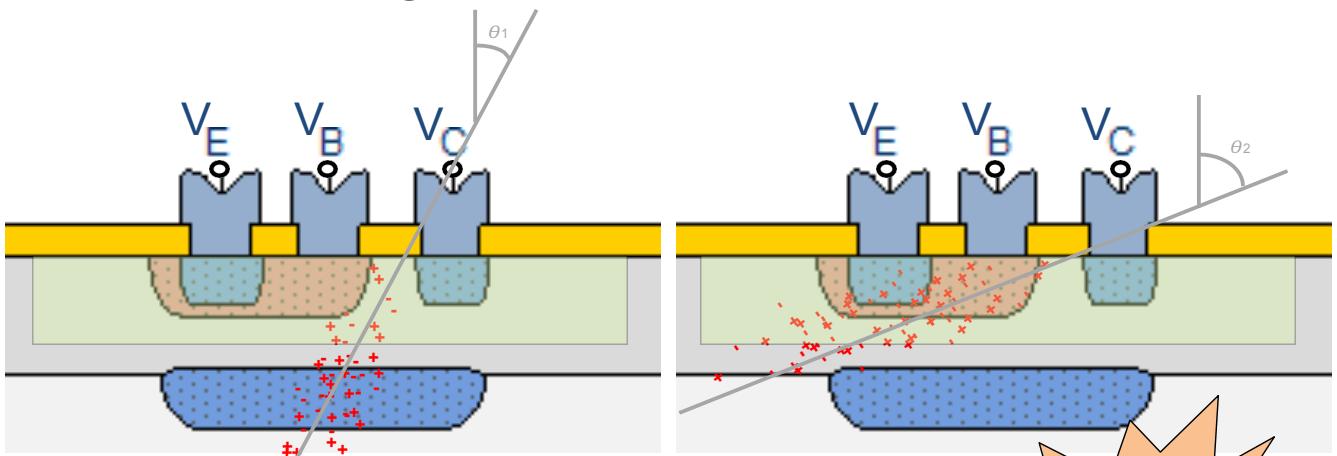
CREATE

Module 3: Single-Event Effects

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Influence of Angle of Incidence

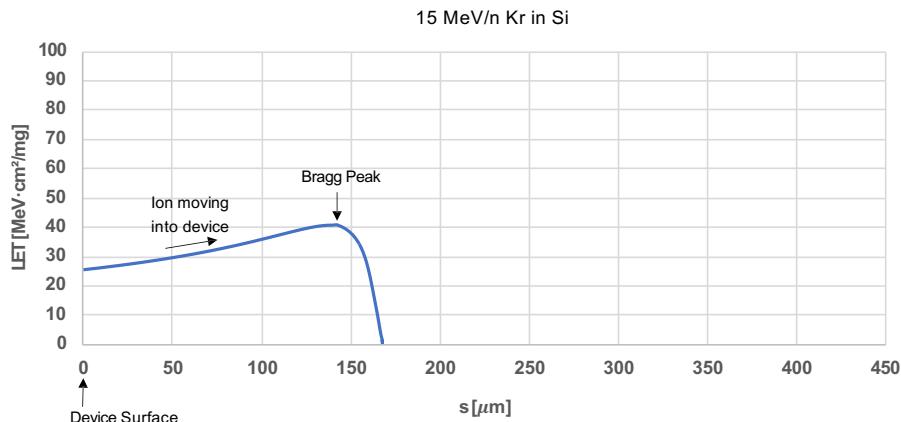


- Larger angle of incidence deposits greater charge in SV
- Comparable to being hit with a higher LET ion
- Effective LET: $LET_{eff} = LET / \cos(\theta)$

Caution: Not all SEE follow $1/\cos(\theta)$



LET as Ion Moves through Material

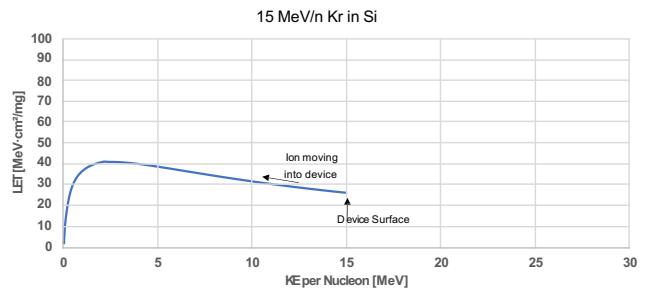
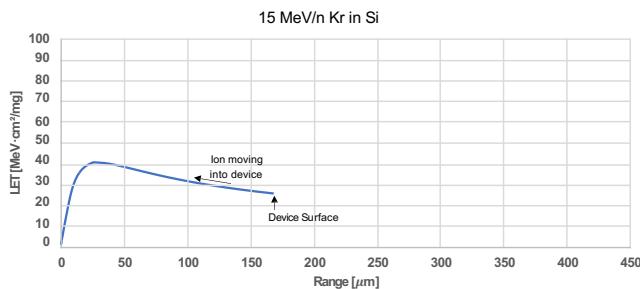
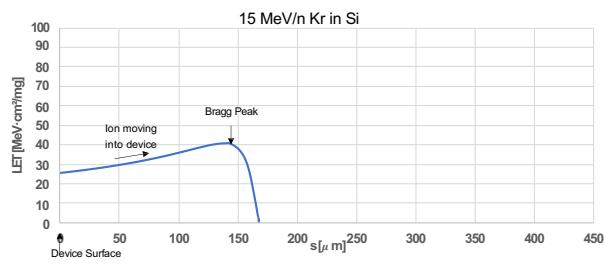


- Bragg Peak = maximum rate of energy deposition
 - Before peak, LET increases as ion slows, increasing the probability of EM interaction
 - After peak, LET decreases as ion picks up electrons, decreasing charge



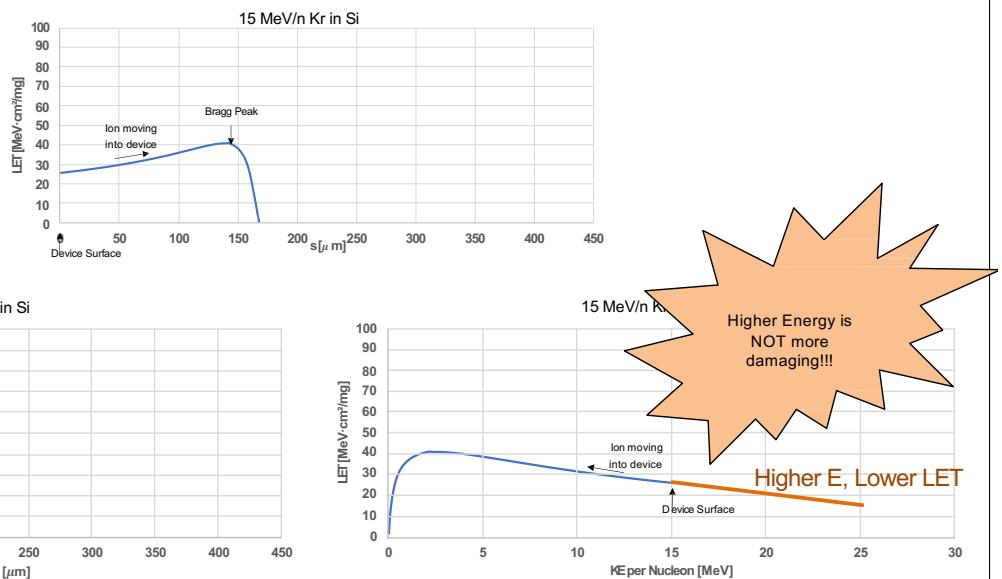
LET as Ion Moves through Material

- 3 common ways to view the same information



LET as Ion Moves through Material

- 3 common ways to view the same information



CREATE

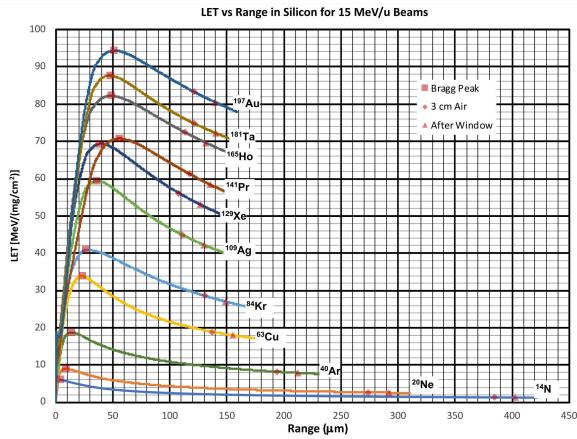
Module 3: Single-Event Effects

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Some Available Beams

TAMU 15 MeV/n Heavy Ions



https://cyclotron.tamu.edu/ref/images/let_vs_range_plots.pdf

LBLN 16 MeV/n Heavy Ions



<https://cyclotron.lbl.gov/base-rad-effects/heavy-ions>



CREATE

Module 3: Single-Event Effects

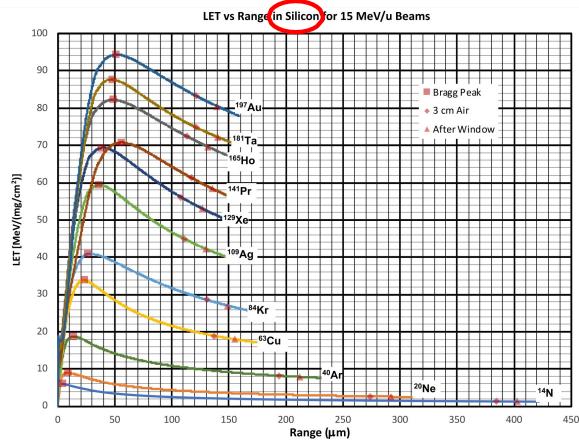
SEE FACILITY BASICS

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Remember the type of beam?

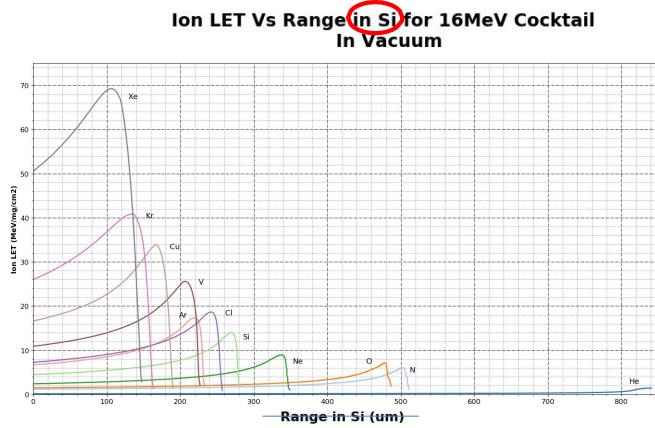
Some Available Beams

TAMU 15 MeV/n Heavy Ions



https://cyclotron.tamu.edu/ref/images/let_vs_range_plots.pdf

LBLN 16 MeV/n Heavy Ions



<https://cyclotron.lbl.gov/base-rad-effects/heavy-ions>



CREATE

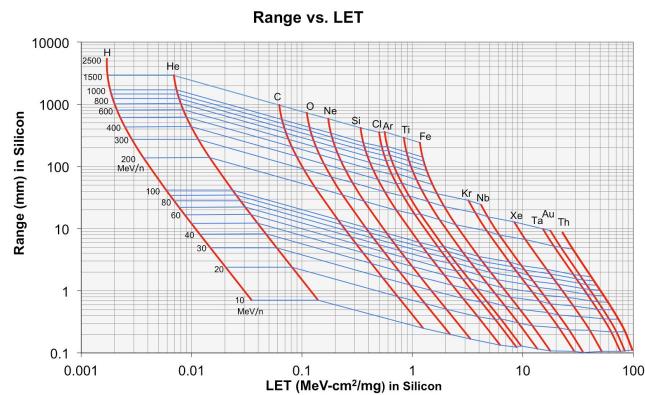
Module 3: Single-Event Effects

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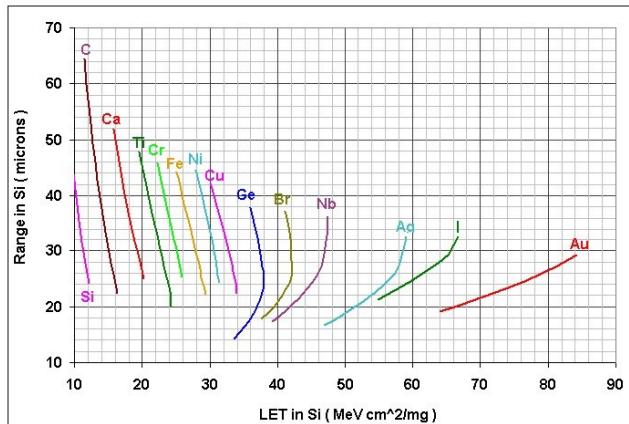
Some Available Beams

NASA Space Radiation Lab (NSRL)



<https://www.bnl.gov/nsrl/userguide/let-range-plots.php>

BNL Tandem VdeG SEU Facility



<https://www.bnl.gov/tandem/capabilities/ions.php>



CREATE

Module 3: Single-Event Effects

SEE FACILITY BASICS

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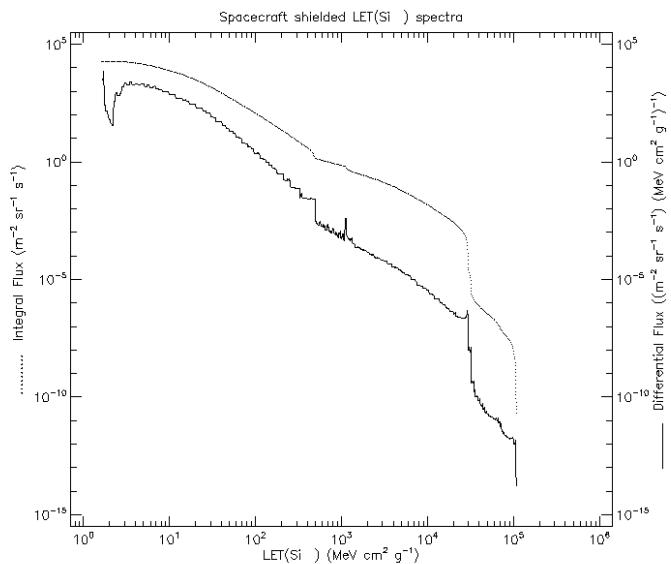
Facility Flux Capabilities and Other Details

- LBNL 88" BASE Facility, TAMU K500, and MSU FRIB all can provide flux levels of between 1E2 and 1E7 ions/cm²-sec (though, in general, 1E4 to 1E5 ions/cm²-sec is typical)
 - <https://cyclotron.lbl.gov/base-rad-effects>
 - <https://cyclotron.tamu.edu/ref/downloads.html#forms>
 - <https://frib.msu.edu/science/fsee/fsee-downloads>
- **Question:** How do these flux levels compare to near-Earth space environments?



Facility Flux Capabilities and Other Details

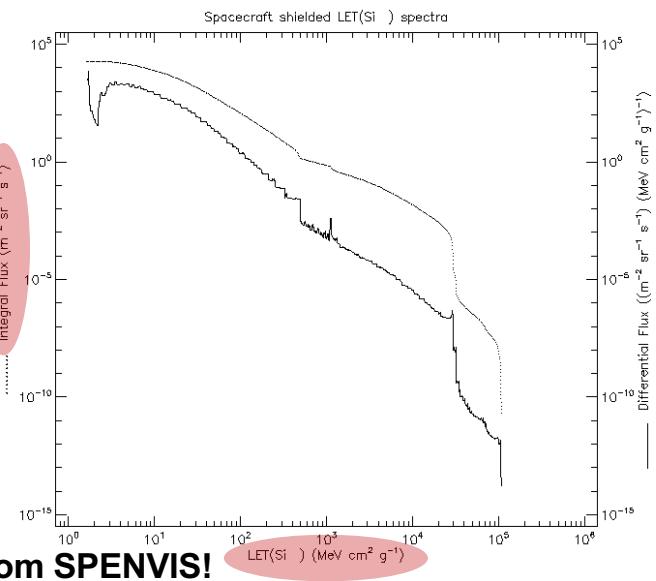
- LBNL 88" BASE Facility, TAMU K! between 1E2 and 1E7 ions/cm²-s is typical)
 - <https://cyclotron.lbl.gov/base-rad/>
 - <https://cyclotron.tamu.edu/ref/dov>
 - <https://frb.msu.edu/science/fsee/>
- **Question:** How do these flux levels compare to near-Earth space environments?



Facility Flux Capabilities and Other Details

- LBNL 88" BASE Facility, TAMU K! between 1E2 and 1E7 ions/cm²-s (is typical)
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 - <https://cyclotron.tamu.edu/ref/dov>
 - <https://frb.msu.edu/science/fsee/>

- **Question:** How do these flux levels compare to near-Earth space environments?



Careful of units from SPENVIS!



CREATE

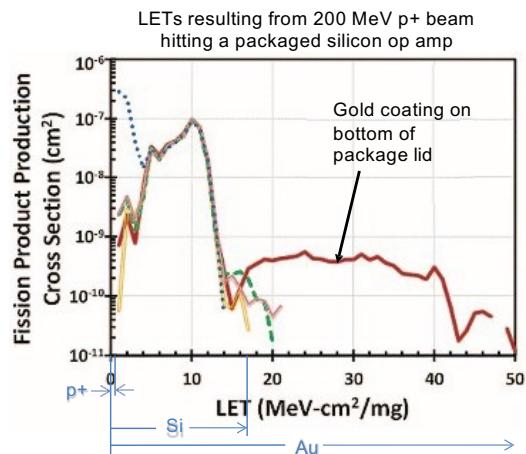
Module 3: Single-Event Effects

SEE FACILITY BASICS

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Note: Nuclear Interactions are Important

- Examples of protons leading to significantly higher LET than is possible with Direct Ionization:
 - Silicon nucleus in device
 - Gold-coated package lids
 - Tungsten plugs



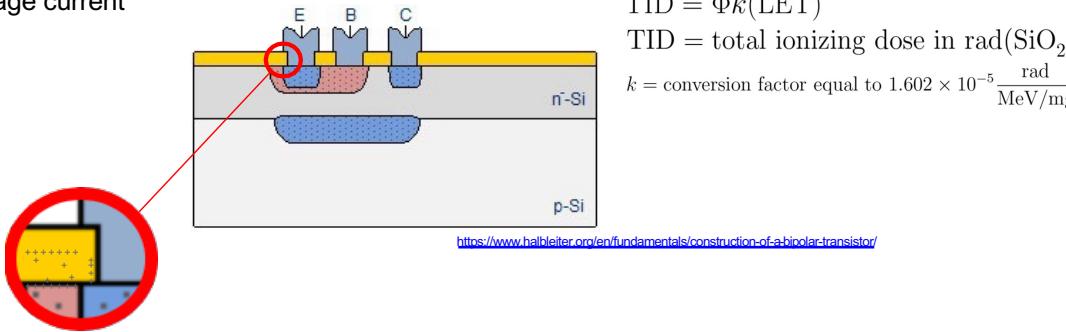
T.L.Turlinger,D.A.P.Clymer,L.W.Mason,S.Stone,J.S.George, M. Savage, R. Koga, E. Beach, and K. Huntington, "RHA implications of proton on gold-plated package structures in SEE evaluations," IEEE Trans. Nucl. Sci., vol. 62, no. 6, pp. 2468-2475, Dec. 2015.



What tools help with this??
GEANT4, CREMEMC, e.g.

Note: Keep Track of Total Ionizing Dose (TID)!

- After the radiation dose, holes trapped in the dielectrics modify the electric fields in the device, leading to
 - Threshold voltage shifts
 - Leakage current



- This is “TID damage” - eventually the device will fail to operate
- Even during SEE testing, you must track TID!



CREATE

Module 3: Single-Event Effects

SEE FACILITY BASICS

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Add tid calculation

Useful Tools and Resources

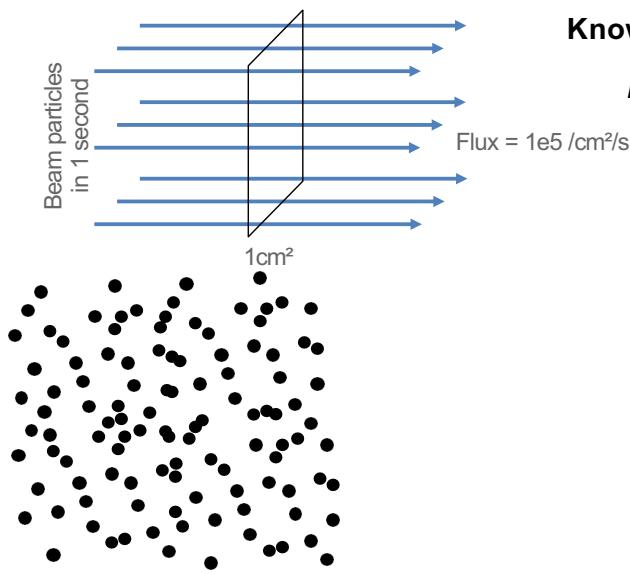
- LET-Range Charts – **start here to get an estimate**
 - LBNL 88" Cyclotron BASE: <https://cyclotron.lbl.gov/base-rad-effects/heavy-ions/cocktails-and-ions>
 - NSRL: <https://www.bnl.gov/nsrl/userguide/let-range-plots.php>
 - TAMU: <https://cyclotron.tamu.edu/ref/downloads.html>
- SRIM – **follow up with analysis of LET**
 - SRIM: <http://www.srim.org>
 - NSRL Stack-Up Tool: <https://www.bnl.gov/nsrl/stackup/>
 - IU web-SRIM (in development)
 - IU web-SRIM on nanoHUB (in development)
- SUESS: <https://mare.cyclotron.tamu.edu/vladimir/SeussW.htm>



05

MEASURING SEE

SEE Cross Section



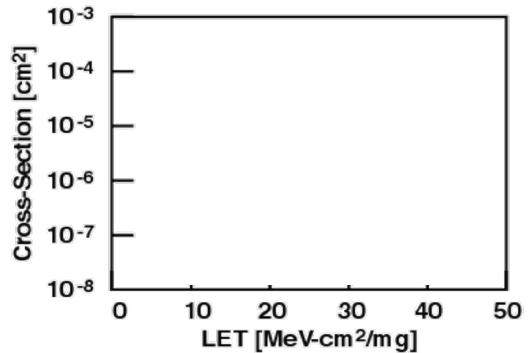
Calculation of Cross-Section

Known Fluence (Ions), LET

Ex. 1000 sec of irradiation to $1e8 \text{ ions/cm}^2$

$\text{LET} = 11, 12, 13 \dots 38 \text{ MeV}\cdot\text{cm}^2/\text{mg}$

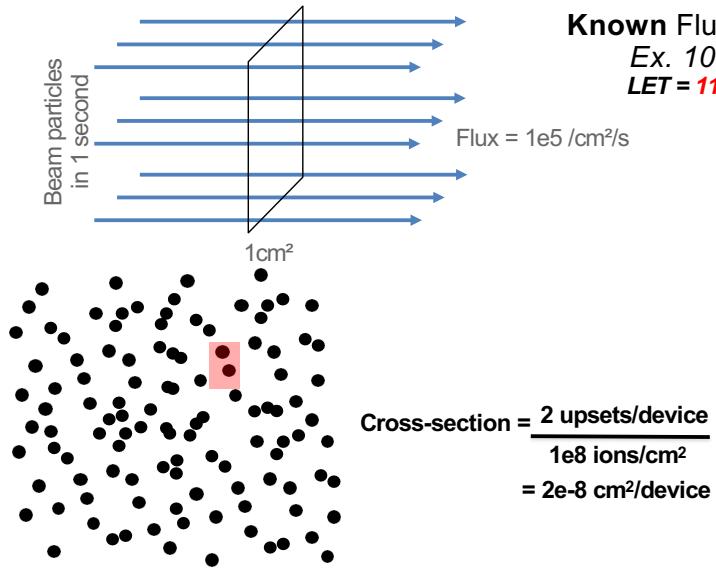
Sensitive Area vs. LET



LET = Linear Energy Transfer



SEE Cross Section



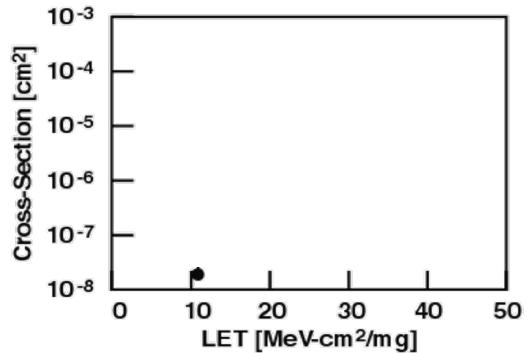
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Sensitive Area vs. LET



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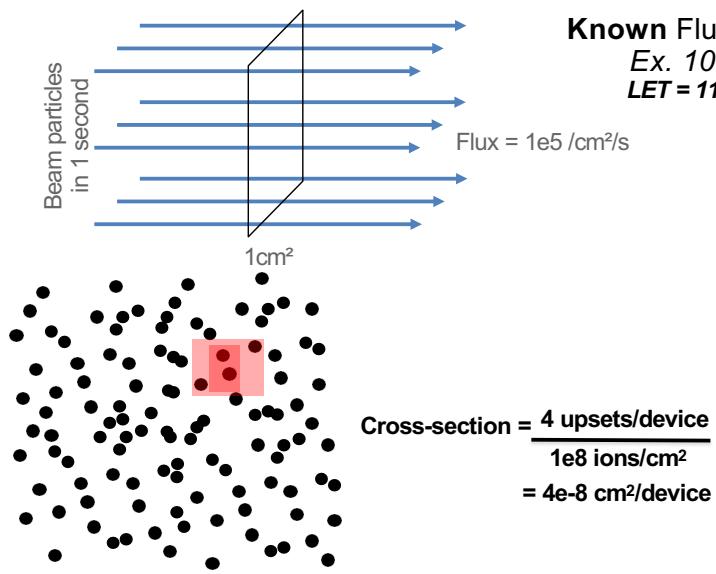
CREATE

Module 3: Single-Event Effects

MEASURING SEE

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SEE Cross Section



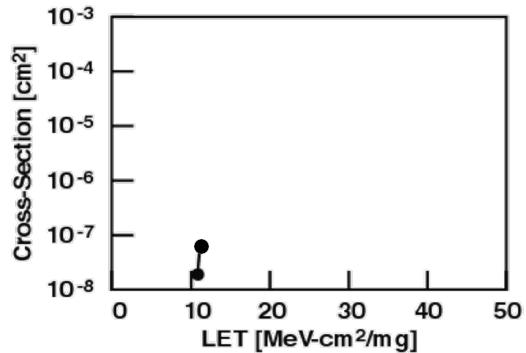
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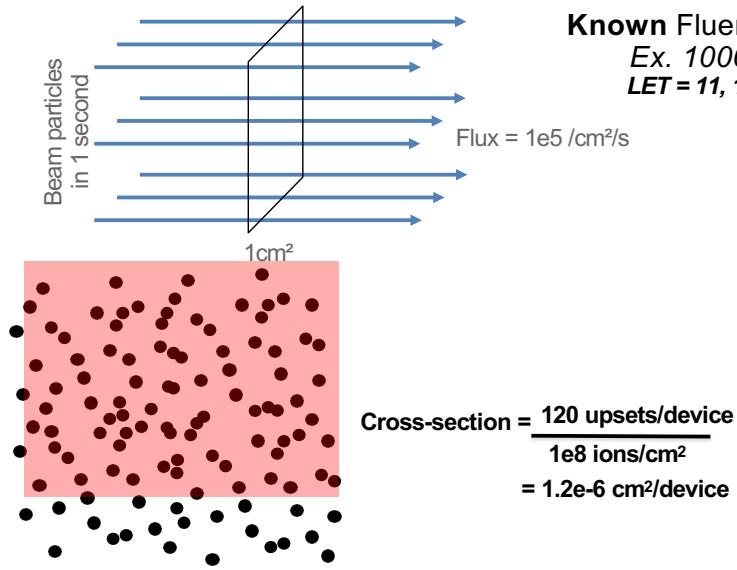
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SEE Cross Section



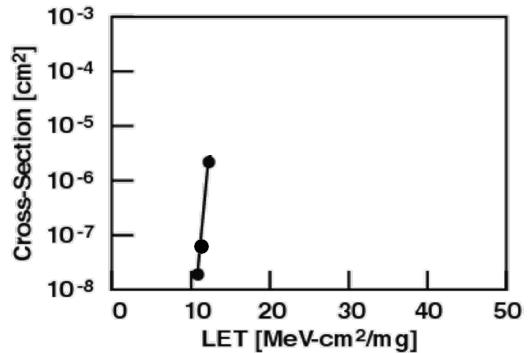
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Sensitive Area vs. LET



LET = Linear Energy Transfer



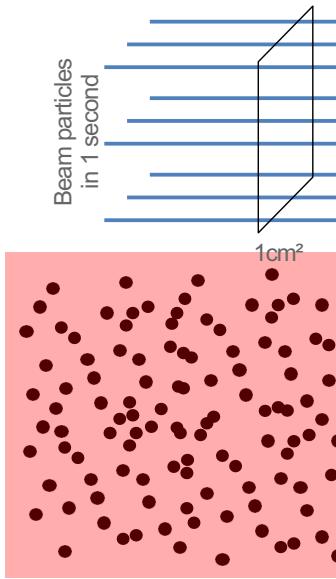
CREATE

Module 3: Single-Event Effects

MEASURING SEE

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SEE Cross Section



Flux = $1e5 \text{ /cm}^2\text{/s}$

Cross-sections are measured vs.
LET until the LET threshold
(onset LET) and saturated (or
limiting) cross-section can be
determined

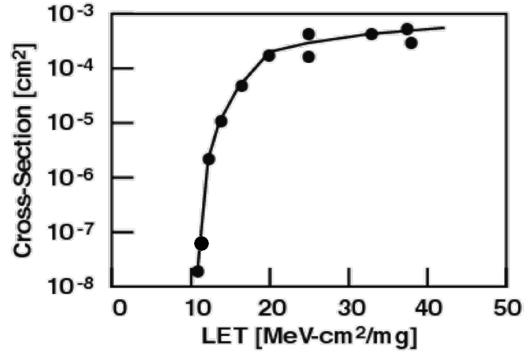
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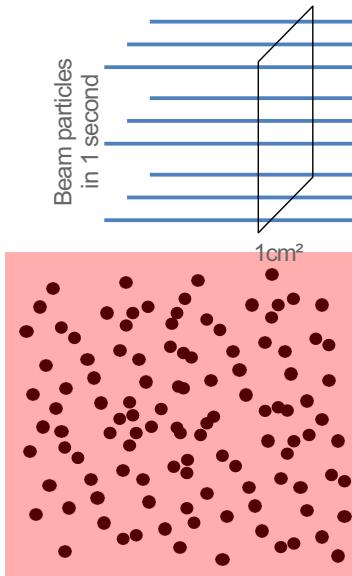
CREATE

Module 3: Single-Event Effects

MEASURING SEE

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SEE Cross Section



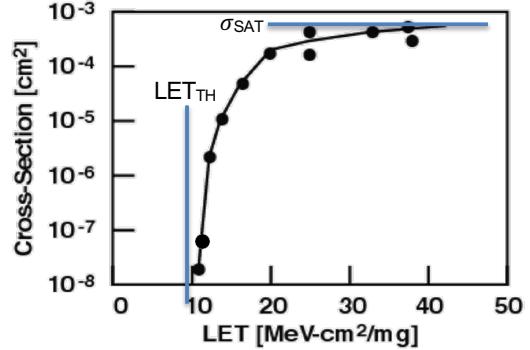
Cross-sections are measured vs. LET until the LET threshold (onset LET) and saturated (or limiting) cross-section can be determined

Calculation of Cross-Section

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Ex. 1000 sec of irradiation to $1e8 \text{ ions/cm}^2$

Sensitive Area vs. LET



LET = Linear Energy Transfer



CREATE

Module 3: Single-Event Effects

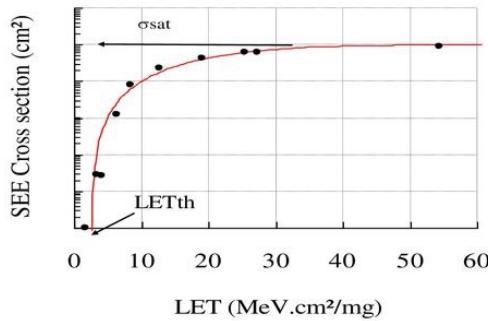
MEASURING SEE

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Goal, LET thresh, sat cross section, and “enough” points in between

Modeling the SEE Cross Section – more in Module 12

- Model cross-section data with a Weibull curve (use a semi-log y scale)
- Fit the model by minimizing the sum of the squared residuals



$$[\text{cm}^2] \longrightarrow \sigma = \frac{N_{\text{events}}}{\text{Fluence}} \longleftarrow [\text{N}_{\text{particules}}/\text{cm}^2]$$

Fit with Weibull (integral form)

$$\sigma = \sigma_{\text{sat}} \left(1 - \exp \left(\frac{\text{LET} - \text{LET}_{\text{th}}}{W} \right)^S \right)$$

W and S are fitting parameters

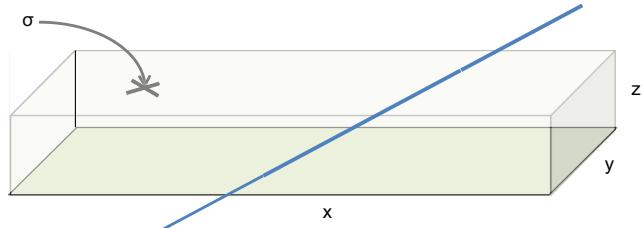
SEE cross-section is a crucial input
for in-orbit SEE rate prediction.



Goal, LET thresh, sat cross section, and “enough” points in between

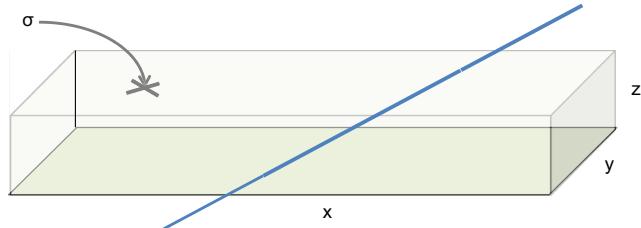
Rectangular Parallel Piped (RPP) Model

- Cross-Section:
 - $\sigma = x * y$
 - The top-down area of the SV (or sensitive area)
- Depth of sensitive volume, z
- Path Length, distance traveled by ion through the SV (———)



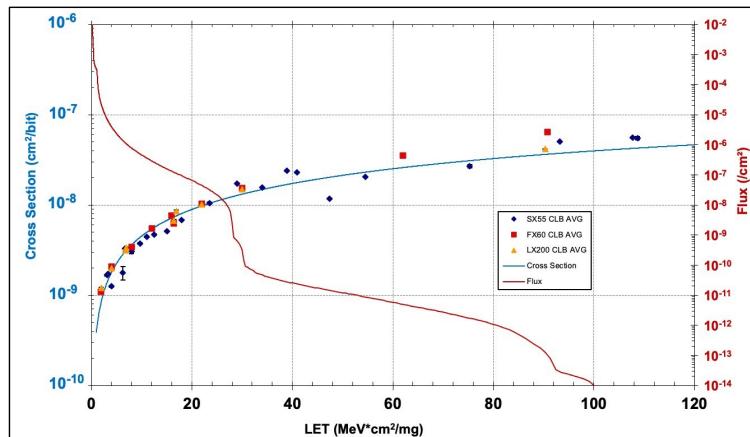
Measuring SV?

- You may need to estimate the SV to use error rate modeling tools
- Experimentally:
 - Measure N, the number of SEE, during a run to fluence,
 - Calculate:
 - $\sigma = N/\phi$
 - $x = y = \sqrt{\sigma}$
 - z
- Many organizations use a "rule of thumb" for determining z
 - Example
 - Typical: $z = x/5$
 - Worst-case: $z = x/100$



From Experiment to On-orbit Rate Estimate

more on this in 3.1



$$\text{Rate} = \underbrace{\int \frac{d\text{flux}(LET, \theta)}{dLET}}_{\text{environment}} \times \underbrace{\sigma(LET, \theta) d\theta}_{\text{device response}} dLET$$



06

PRACTICAL CONSIDERATIONS

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Example: LBNL 88" Cyclotron BASE Facility



CREATE

Module 3: Single-Event Effects

PRACTICAL CONSIDERATIONS

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About the facility

- 88" Cyclotron built in the 60s
- Heavy ions available in "cocktails"
- Example 16 MeV/amu cocktail below – don't rely on quoted LET values!

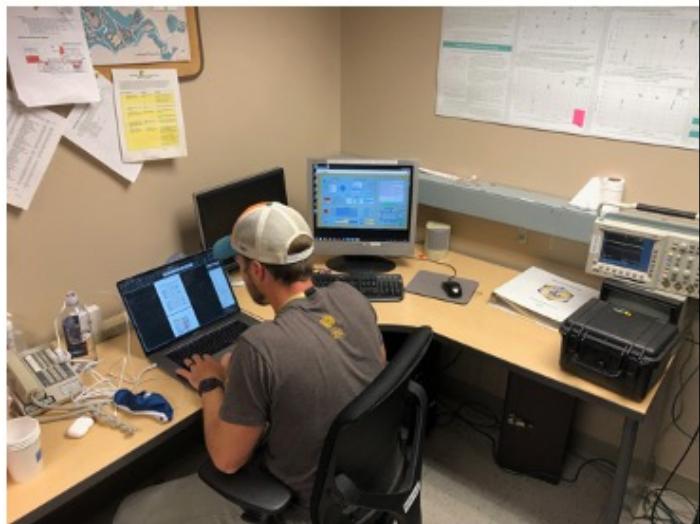
Ion	Cocktail	Energy	Z	A	Chg. State	% Nat. Abund.	LET (Entrance)
		(AMeV)	(MeV)				(MeV/mg/cm ²)
He*	16	43.46	2	3	+1	0.000137	0.11
N	16	233.75	7	14	+5	99.63	1.16
O	16	277.33	8	17	+6	0.04	1.54
Ne	16	321.00	10	20	+7	90.48	2.39
Si	16	452.10	14	29	+10	4.67	4.56
Cl	16	539.51	17	35	+12	75.77	6.61
Ar	16	642.36	18	40	+14	99.600	7.27
V	16	832.84	23	51	+18	99.750	10.90
Cu	16	1007.34	29	63	+22	69.17	16.53
Kr	16	1225.54	36	78	+27	0.35	24.98
Xe*	16	1954.71	54	124	+43	0.1	49.29

Source: [LBNL Cyclotron Ion Cocktails](#)



About the facility

- Advantages
 - Changing ions (LET) is fast and easy
 - Usually just a few minutes
 - Not the case at other facilities!
 - Flux can be tuned with attenuators
 - They have a sparkling water machine



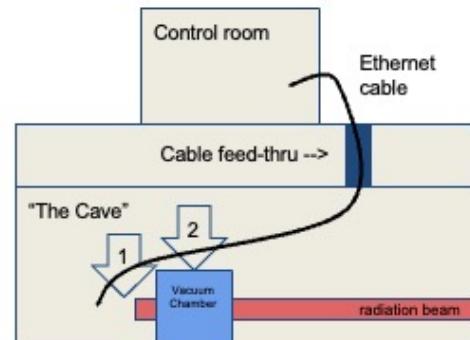
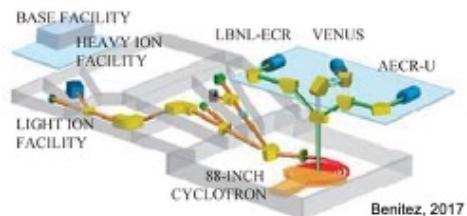
About the facility

- Disadvantages
 - The beam goes down often for hours at a time
 - The beam runs 24 hours/day so you lose a lot of sleep



Setting up your system

- The control room sits directly above the beam chamber
- There is a tube into the chamber where you can run cables
- 60 feet of cables will be plenty to reach your test system
- Outside the vacuum chamber (position 1) you do not need to worry about bulkhead connectors
- Using the vacuum chamber (position 2) you need to know what connections will be available and will need extra cables
- Some cocktails (such as 10 MeV/amu) require the vacuum chamber



Setting up your system

Pro tip: They will have plenty of clamps and mounts there. You should worry more about cabling



Cabling

Pro tip: Bring extra cables (of every type), connectors. Use the cables you have tested with and verified



Courtesy
NASA GSFC



CREATE

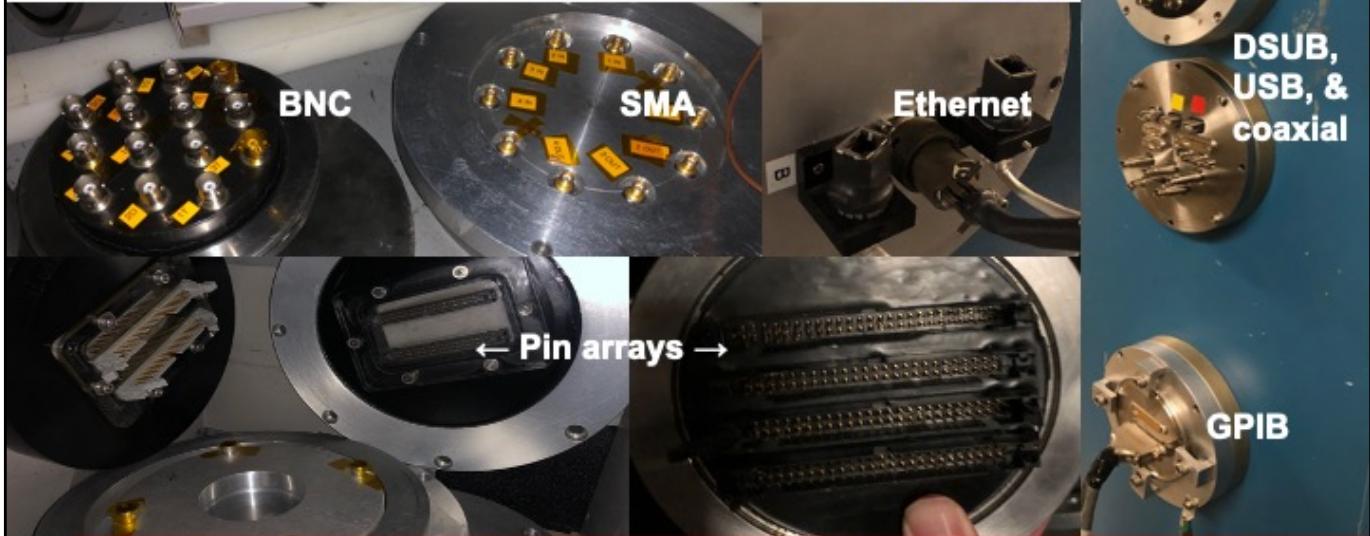
Module 3: Single-Event Effects

PRACTICAL CONSIDERATIONS

100

Vacuum chamber bulkhead connections

More info:
[88-Inch Cyclotron - Heavy Ions \(lbl.gov\)](#)



CREATE

Module 3: Single-Event Effects

PRACTICAL CONSIDERATIONS

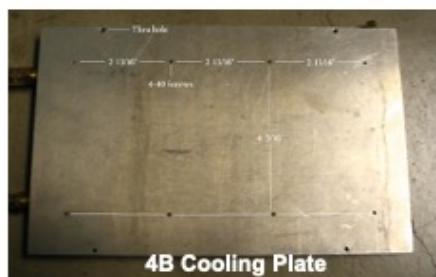
101

Vacuum chamber

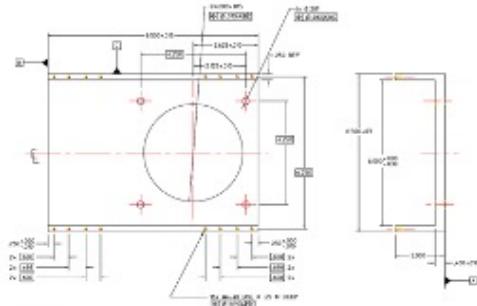
- Tests can be performed in air for the 16, 20, and 30 MeV Cocktails
- All cocktails can be performed under vacuum
- While in vacuum the angel can be changed from the control room
- More info: [88-inch Cyclotron - 4B Drawings \(lbl.gov\)](#)



4B Mounting Bracket



4B Cooling Plate



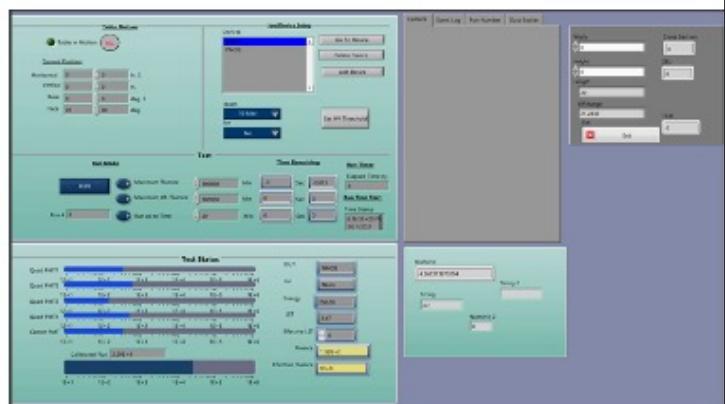
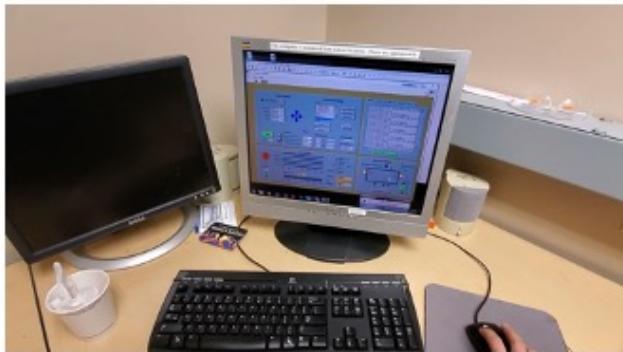
Before heading to California...

- Decapsulate your parts as soon as possible
- Ship your gear early
- Checked baggage has to be $\leq 99\text{lb}$
- Request specific ions if necessary



Tips on being prepared

- Familiarize yourself with the software
- Bring snacks and something to kill time
- Rest as much as possible beforehand



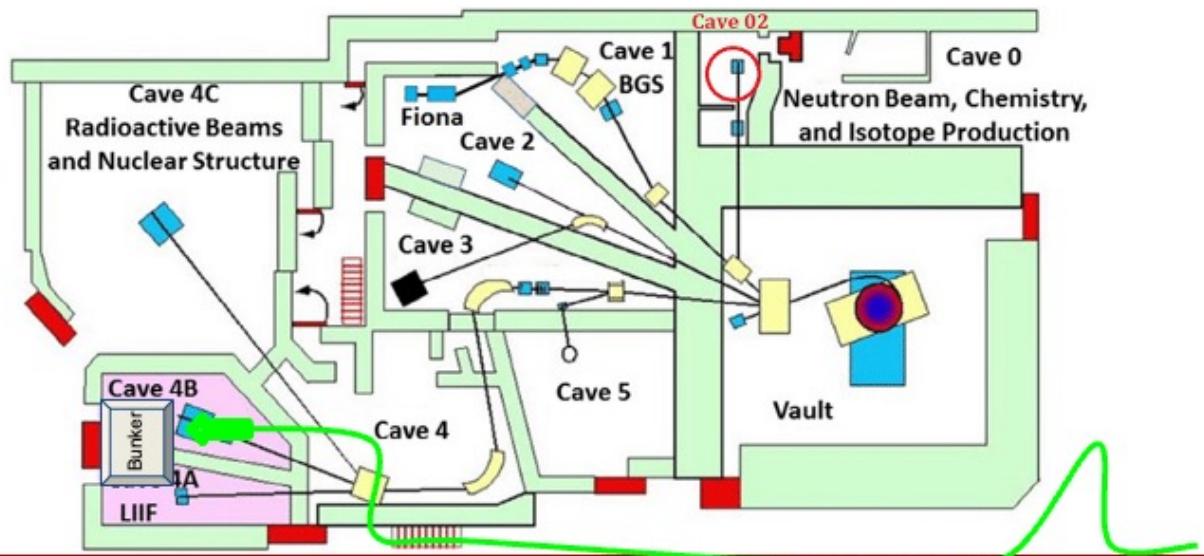
CREATE

Module 3: Single-Event Effects

PRACTICAL CONSIDERATIONS

104

Walking to the Bunker



Walking to the Bunker



Cave 4B



CREATE

Module 3: Single-Event Effects

PRACTICAL CONSIDERATIONS

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Getting data

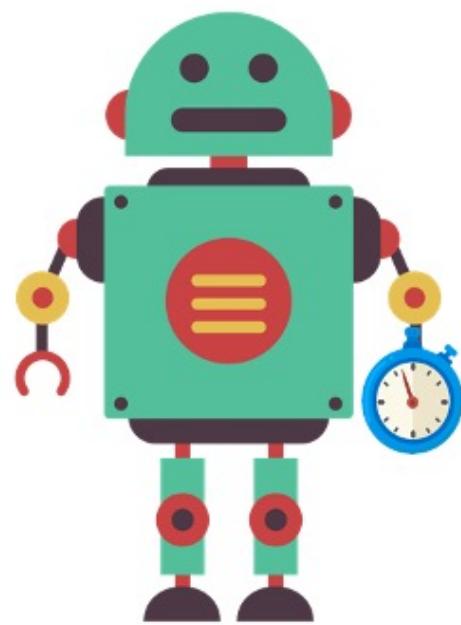
- Usually tests are broken up into short runs 1 to 5 minutes long
- You can do longer runs, you just need to plan accordingly
- Make sure that all data logs have the same run numbers
- Periodically check that the run numbers are in sync
- Spreadsheets are great!
- You can also generate them automatically with scripts

	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O	P	Q	R	S	T	U	V	W
1	#	Ion	LET (eV DUTs)	File	Dose	Time	VDD (V)	Fluence (nm Avg I)	Peak	A1 SEUs	A2 SEUs	A3 SEUs	C1 SEUs	C2 SEUs	C3 SEUs	Dose (eV)	TID (keV)	SEU X8 (1)	SEU X8 (2)				
2	0	N	1.16	H01, H02, HO: data/ram/iseuH_check.csv	1	60	0.7	4.20E+00	0*								78.05	0.08	#D/W/0				
3	1	N	1.16	H01, H02, HO: data/ram/iseuH_check.csv	1	60	0.7	5.32E+00	0*								98.86	0.18	#D/W/0				
4	2	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar.csv	1	60	0.7	5.22E+00	144384	129024	137216	11264				607.95	0.78	2.62E-02					
5	3	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar.csv	1	60	0.7	5.44E+00	8192	7168	143326	142336				635.90	1.42	1.81E-03					
6	4	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar.csv	1	60	1	5.19E+00	6144	4096	3072	8192				604.46	2.03	8.55E-04					
7	5	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar.csv	1	60	1.3	5.34E+00	6144	2048	2048	4096				621.93	2.65	6.39E-04					
8	6	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar.csv	1	60	3.8	5.30E+00	3072	4096	3072	1024				617.27	3.26	6.44E-04					
9	7	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar_new.csv	1	60	0.7	5.70E+00								663.85	3.93	#D/W/0					
10	8	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar_new.csv	1	60	1	5.71E+00	131072*	6755	131072*	12541				665.02	4.59	1.16E-03					
11	9	Ar	7.27	H01, H02, HO: data/ram/iseuH_Ar_new.csv	1	60	1.3	5.49E+00								638.23	5.23	#D/W/0					
12	10	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	60	0.7	5.23E+00	24816	24745	23564					609.11	0.81	4.88E-03					
13	11	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	60	0.7	5.11E+00	24478	23879	22624					595.14	1.29	4.69E-03					
14	12	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	60	0.6	5.18E+00	21601	21923	20889					603.29	1.81	4.14E-03					
15	13	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	60	1.5	6.36E+00	20691	18395	16824					740.72	2.55	2.93E-03					
16	14	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	60	2.4	1.33E+00								15.49	2.56	#D/W/0					
17	15	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	11	2.4	4.52E+00	?????							82.54	2.62	#D/W/0					
18	16	Ar	7.27	I01, I02, I03: data/ram/iseuI_Ar.csv	1	10	2.4	4.36E+00								60.78	2.87	#D/W/0					



Getting data

- Automate, automate, automate!
- This will save a lot of time and headache
- Use Python, MATLAB, VBA, or whatever tools are available
- Minimize user interactions
- Move quickly - time is a commodity
- Prioritize the most relevant data and optimize the run order
- Consider testing multiple parts or conditions simultaneously



Acronyms

- B: Magnetic Field
- BNL: Brookhaven National Laboratory
- δ : Density
- FRIB: Facility for Rare Isotopes Beam
- IU: Indiana University
- LBNL: Lawrence Berkeley National Laboratory
- LET: Linear Energy Transfer
- LET_{TH} : Threshold LET
- LINAC: Linear accelerator
- MSU: Michigan State University
- N: Number of Events or Particles
- NSRL: NASA Space Radiation Laboratory
- Q_{CRIT} : Critical Charge
- RF: Radio Frequency
- RPP: Rectangular Parallel Piped
- s: Path Length (& sometimes range)
- σ : Cross section
- σ_{SAT} : Saturated σ
- S: Shape Parameter in Weibull Distribution
- SEE: Single Event Effects
- SRIM: Stopping Range of Ions in Matter
- SUESS: TAMU's Cyclotron Institute Radiation Effects Facility Control Software
- SV: Sensitive Volume
- t: Thickness
- θ : Incident Angle
- TAMU: Texas A&M University
- TID: Total Ionizing Dose
- TRIUMF: Tri-University Meson Facility
- TvdG: Tandem Van der Graff
- W: Width Parameter in Weibull Distribution
- x: Length of SV
- y: Width of SV
- z: Depth of SV
- Z: Atomic Number



Pause, ask question to connect to accel type